# **ADVANCE INFORMATION**



# i960® RP I/O PROCESSOR

- 33 MHz, 5.0 Volt Version (80960RP 33/5.0)
   Complies with PCI Local Bus Specification Revision 2.1
- High Performance 80960JF Core
  - Sustained One Instruction/Clock Execution
  - 4 Kbyte Two-Way Set-Associative Instruction Cache
  - 2 Kbyte Direct-Mapped Data Cache
  - Sixteen 32-Bit Global Registers
  - Sixteen 32-Bit Local Registers
  - Programmable Bus Widths: 8-, 16-, 32-Bit
  - 1 Kbyte Internal Data RAM
  - Local Register Cache (Eight Available Stack Frames)
  - Two 32-Bit On-Chip Timer Units
- PCI-to-PCI Bridge Unit
  - Primary and Secondary PCI Interfaces
  - Two 64-Byte Posting Buffers
  - Delayed and Posted Transaction Support
  - Forwards Memory, I/O, Configuration Commands from PCI Bus to PCI Bus
- Two Address Translation Units
  - Connects Local Bus to PCI Buses
  - Inbound/Outbound Address Translation Support
  - Direct Outbound Addressing Support
- Messaging Unit
  - Four Message Registers
  - Two Doorbell Registers
  - Four Circular Queues
  - 1004 Index Registers
- Memory Controller
  - 256 Mbvtes of 32- or 36-Bit DRAM
  - Interleaved or Non-Interleaved DRAM
  - Fast Page-Mode DRAM Support
  - Extended Data Out and Burst
  - Extended Data Out DRAM Support
  - Two Independent Banks for SRAM / ROM / Flash (16 Mbytes/Bank; 8- or 32-Bit)

#### DMA Controller

- Three Independent Channels
- PCI Memory Controller Interface
- 32-Bit Local Bus Addressing
- 64-Bit PCI Bus Addressing
- Independent Interface to Primary and Secondary PCI Buses
- 132 Mbyte/sec Burst Transfers to PCI and Local Buses
- Direct Addressing to and from PCI Buses
- Unaligned Transfers Supported in Hardware
- Two Channels Dedicated to Primary PCI Bus
- One Channel Dedicated to Secondary PCI Bus
- I/O APIC Bus Interface Unit
  - Multiprocessor Interrupt Management for Intel Architecture CPUs (Pentium<sup>®</sup> and Pentium<sup>®</sup> Pro Processors)
  - Dynamic Interrupt Distribution
  - Multiple I/O Subsystem Support
- I<sup>2</sup>C Bus Interface Unit
  - Serial Bus
  - Master/Slave Capabilities
  - System Management Functions
- Secondary PCI Arbitration Unit
  - Supports Six Secondary PCI Devices

Order Number: 272737-003

- Multi-priority Arbitration Algorithm
- External Arbitration Support Mode
- Private PCI Device Support
- SuperBGA\* Package
  - 352 Ball-Grid Array (HL-PBGA)

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#### 1.0 ABOUT THIS DOCUMENT

This data sheet contains advance information about Intel's i960 RP I/O processor at 5 Volts (referred to as 80960RP 33/5.0), including a functional overview, mechanical data (package signal locations and simulated thermal characteristics), targeted electrical specifications (simulated), and bus functional waveforms. Detailed functional descriptions other than parametric performance is published in the i960<sup>®</sup> RP Microprocessor User's Guide (272736).

# 1.1 Solutions 960<sup>®</sup> Program

Intel's Solutions960® program features a wide variety of development tools which support the i960 processor family. Many of these tools are developed by partner companies; some are developed by Intel, such as profile-driven optimizing compilers. For more information on these products, contact your local Intel representative.

# 1.2 Terminology

In this document, the following terms are used:

- local bus refers to the 80960RP 33/5.0's internal local bus, not the PCI local bus.
- Primary and Secondary PCI buses are the 80960RP 33/5.0's internal PCI buses which conform to PCI SIG specifications.
- 80960 core refers to the 80960JF processor which is integrated into the 80960RP 33/5.0.

# 1.3 Additional Information Sources

Intel documentation is available from your local Intel Sales Representative or Intel Literature Sales.

Intel Corporation Literature Sales P.O. Box 7641 Mt. Prospect IL 60056-7641 1-800-879-4683

Table 1	Related	Documentation

Document Title	Order / Contact
i960 <sup>®</sup> RP Microprocessor User's Guide	Intel Order # 272736
i960® RP Processor: A Single-Chip Intelligent I/O Subsystem Technical Brief	Intel Order # 272738
i960 <sup>®</sup> Jx Microprocessor User's Guide	Intel Order # 272483
80960RP Specification Update	Intel Order # 272918
PCI Local Bus Specification Revision 2.1	PCI Special Interest Group 1-800-433-5177
PCI-to-PCI Bridge Architecture Specification Revision 1.0	PCI Special Interest Group 1-800-433-5177
f <sup>2</sup> C Peripherals for Microcontrollers	Philips Semiconductor

#### 1.4 Electronic Information

Intel's World-Wide Web (WWW) Location:	http://www.intel.com				
Customer Support (US and Canada):	800-628-8686				
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#### 2.0 FUNCTIONAL OVERVIEW

As indicated in Figure 1, the 80960RP 33/5.0 combines many features with the 80960JF to create an intelligent I/O processor. Subsections following the figure briefly describe the main features; for detailed functional descriptions, refer to the *i960*® RP Microprocessor User's Guide (272736).

The PCI bus is an industry standard, high performance, low latency system bus that operates up to 132 Mbyte/s. The 80960RP 33/5.0, a multi-function PCI device, is fully compliant with the *PCI Local Bus Specification* Revision 2.1. Function 0 is the PCI-to-PCI bridge unit; Function 1 is the address translation unit.

The PCI-to-PCI bridge unit is the connection path between two independent 32-bit PCI buses and provides the ability to overcome PCI electrical load limits. The addition of the i960 core processor brings intelligence to the bridge.

The 80960RP 33/5.0, object code compatible with the i960 core processor, is capable of sustained execution at the rate of one instruction per clock.

The local bus, a 32-bit multiplexed burst bus, is a high-speed interface to system memory and I/O. A full complement of control signals simplifies the connection of the 80960RP 33/5.0 to external components. Physical and logical memory attributes are programmed via memory-mapped control registers (MMRs), an extension not found on the i960 Kx, Sx or Cx processors. Physical and logical configuration registers enable the processor to operate with all combinations of bus width and data object alignment.

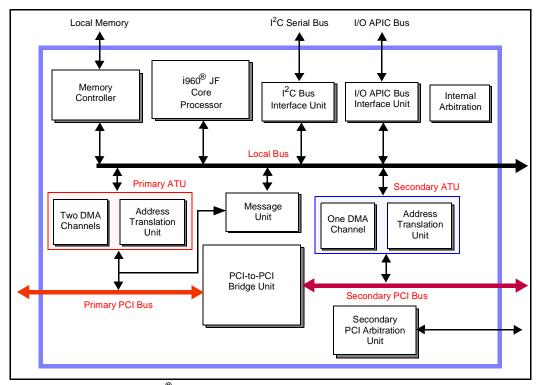


Figure 1. i960® RP I/O Processor at 5 Volts Functional Block Diagram



### 2.1 Key Functional Units

#### 2.1.1 PCI-to-PCI Bridge Unit

The PCI-to-PCI bridge unit (referred to as "bridge") connects two independent PCI buses. It is fully compliant with the *PCI-to-PCI Bridge Architecture Specification* Revision 1.0 published by the PCI Special Interest Group. It allows certain bus transactions on one PCI bus to be forwarded to the other PCI bus. Dedicated data queues support high performance bandwidth on the PCI buses. The i960® RP I/O Processor at 5 Volts supports PCI 64-bit Dual Address Cycle (DAC) addressing.

The bridge has dedicated PCI configuration space that is accessible through the primary PCI bus.

#### 2.1.2 Private PCI Device Support

A key design feature is that the 80960RP 33/5.0 explicitly supports private PCI devices on the secondary PCI bus without being detected by PCI configuration software. The bridge and Address Translation Unit work together to hide private devices from PCI configuration cycles and allow these devices to use a private PCI address space. The Address Translation Unit uses normal PCI configuration cycles to configure these devices.

#### 2.1.3 DMA Controller

The DMA Controller supports low-latency, high-throughput data transfers between PCI bus agents and 80960 local memory. Three separate DMA channels accommodate data transfers: two for primary PCI bus, one for the secondary PCI bus. The DMA Controller supports chaining and unaligned data transfers. It is programmable only through the i960 core processor.

#### 2.1.4 Address Translation Unit

The Address Translation Unit (ATU) allows PCI transactions direct access to the 80960RP 33/5.0 local memory. The 80960RP 33/5.0 has direct access to both PCI buses. The ATU supports transactions between PCI address space and 80960RP 33/5.0 address space.

Address translation is controlled through programmable registers accessible from both the PCI interface and the 80960 core. Dual access to registers allows flexibility in mapping the two address spaces.

#### 2.1.5 Messaging Unit

The Messaging Unit (MU) provides data transfer between the PCI system and the 80960RP 33/5.0. It uses interrupts to notify each system when new data arrives. The MU has four messaging mechanisms. Each allows a host processor or external PCI device and the 80960RP 33/5.0 to communicate through message passing and interrupt generation. The four mechanisms are Message Registers, Doorbell Registers, Circular Queues, and Index Registers.

#### 2.1.6 Memory Controller

The Memory Controller allows direct control of external memory systems, including DRAM, SRAM, ROM and Flash Memory. It provides a direct connect interface to memory that typically does not require external logic. It features programmable chip selects, a wait state generator and byte parity. External memory can be configured as PCI addressable memory or private processor memory.

#### 2.1.7 I<sup>2</sup>C Bus Interface Unit

The I<sup>2</sup>C (Inter-Integrated Circuit) Bus Interface Unit allows the 80960 core to serve as a master and slave device residing on the I<sup>2</sup>C bus. The I<sup>2</sup>C bus is a serial bus developed by Philips Semiconductor consisting of a two pin interface. The bus allows the 80960RP 33/5.0 to interface to other I<sup>2</sup>C peripherals and microcontrollers for system management functions. It requires a minimum of hardware for an economical system to relay status and reliability information on the I/O subsystem to an external device. For more information, see I<sup>2</sup>C Peripherals for Microcontrollers (Philips Semiconductor)

#### 2.1.8 I/O APIC Bus Interface Unit

The I/O APIC Bus Interface Unit provides an interface to the three-wire Advanced Programmable Interrupt Controller (APIC) bus that allows I/O APIC emulation in software. Interrupt messages can be sent on the bus and EOI messages can be received.



#### 2.1.9 Secondary PCI Arbitration Unit

The Secondary PCI Arbitration Unit provides PCI arbitration for the secondary PCI bus. It includes a fairness algorithm with programmable priorities and six PCI Request and Grant signal pairs. This arbitration unit can also be disabled to allow for external arbitration.

# 2.2 i960 Core Features (80960JF)

The processing power of the 80960RP 33/5.0 comes from the 80960JF processor core. The 80960JF is a new, scalar implementation of the 80960 Core Architecture. Figure 2 shows a block diagram of the 80960JF Core processor.

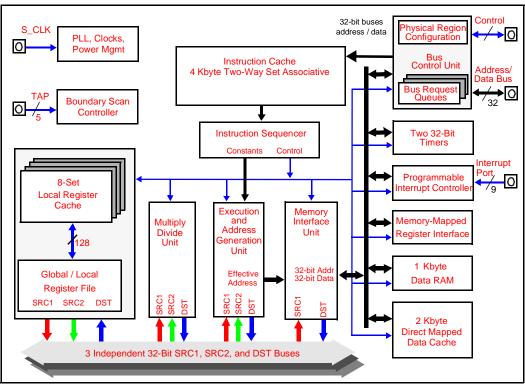


Figure 2. 80960JF Core Block Diagram



Factors that contribute to the 80960 family core's performance include:

- Single-clock execution of most instructions
- · Independent Multiply/Divide Unit
- Efficient instruction pipeline minimizes pipeline break latency
- Register and resource scoreboarding allow overlapped instruction execution
- 128-bit register bus speeds local register caching
- 4 Kbyte two-way set-associative, integrated instruction cache
- · 2 Kbyte direct-mapped, integrated data cache
- 1 Kbyte integrated data RAM delivers zero wait state program data

The 80960 core operates out of its own 32-bit address space, which is independent of the PCI address space. The local bus memory can be:

- · Made visible to the PCI address space
- Kept private to the 80960 core
- · Allocated as a combination of the two

#### 2.2.1 Burst Bus

A 32-bit high-performance bus controller interfaces the 80960RP 33/5.0 to external memory and peripherals. The Bus Control Unit fetches instructions and transfers data on the local bus at the rate of up to four 32-bit words per six clock cycles. The external address/data bus is multiplexed.

Users may configure the 80960RP 33/5.0's bus controller to match an application's fundamental memory organization. Physical bus width is programmable for up to eight regions. Data caching the programmed through a group of logical memory templates and a defaults register. The Bus Control Unit's features include:

- · Multiplexed external bus minimizes pin count
- 32-, 16- and 8-bit bus widths simplify I/O interfaces
- External ready control for address-to-data, data-to-data and data-to-next-address wait state types
- · Little endian byte ordering
- Unaligned bus accesses performed transparently
- Three-deep load/store queue decouples the bus from the 80960 core

Upon reset, the 80960RP 33/5.0 conducts an internal self test. Before executing its first instruction, it performs an external bus confidence test by performing a checksum on the first words of the Initialization Boot Record.

#### 2.2.2 Timer Unit

The timer unit (TU) contains two independent 32-bit timers that are capable of counting at several clock rates and generating interrupts. Each is programmed by use of the Timer Unit registers. These memory-mapped registers are addressable on 32-bit boundaries. The timers have a single-shot mode and autoreload capabilities for continuous operation. Each timer has an independent interrupt request to the 80960RP 33/5.0's interrupt controller. The TU can generate a fault when unauthorized writes from user mode are detected.

#### 2.2.3 Priority Interrupt Controller

Low interrupt latency is critical to many embedded applications. As part of its highly flexible interrupt mechanism, the 80960RP 33/5.0 exploits several techniques to minimize latency:

- Interrupt vectors and interrupt handler routines can be reserved on-chip
- Register frames for high-priority interrupt handlers can be cached on-chip
- The interrupt stack can be placed in cacheable memory space

#### 2.2.4 Faults and Debugging

The 80960RP 33/5.0 employs a comprehensive fault model. The processor responds to faults by making implicit calls to a fault handling routine. Specific information collected for each fault allows the fault handler to diagnose exceptions and recover appropriately.

The processor also has built-in debug capabilities. Via software, the 80960RP 33/5.0 may be configured to detect as many as seven different trace event types. Alternatively, **mark** and **fmark** instructions can generate trace events explicitly in the instruction stream. Hardware breakpoint registers are also available to trap on execution and data addresses.



#### 2.2.5 On-Chip Cache and Data RAM

Memory subsystems often impose substantial wait state penalties. The 80960RP 33/5.0 integrates considerable storage resources on-chip to decouple CPU execution from the external bus. It also includes a 4 Kbyte instruction cache, a 2 Kbyte data cache and 1 Kbyte data RAM.

#### 2.2.6 Local Register Cache

The 80960RP 33/5.0 rapidly allocates and deallocates local register sets during context switches. The processor needs to flush a register set to the stack only when it saves more than seven sets to its local register cache.

#### 2.2.7 Test Features

The 80960RP 33/5.0 incorporates numerous features that enhance the user's ability to test both the processor and the system to which it is attached. These features include ONCE (On-Circuit Emulation) mode and Boundary Scan (JTAG).

The 80960RP 33/5.0 provides testability features compatible with IEEE Standard Test Access Port and Boundary Scan Architecture (IEEE Std. 1149.1).

One of the boundary scan instructions, HIGHZ, forces the processor to float all its output pins (ONCE mode). ONCE mode can also be initiated at reset without using the boundary scan mechanism.

ONCE mode is useful for board-level testing. This feature allows a mounted 80960RP 33/5.0 to electrically "remove" itself from a circuit board. This mode allows system-level testing where a remote tester can exercise the processor system.

The test logic does not interfere with component or system behavior and ensures that components function correctly, and also the connections between various components are correct.

The JTAG Boundary Scan feature is an alternative to conventional "bed-of-nails" testing. It can examine connections that might otherwise be inaccessible to a test system.

#### 2.2.8 Memory-Mapped Control Registers

The 80960RP 33/5.0 is compliant with 80960 family architecture and has the added advantage of memory-mapped, internal control registers not found on the 80960Kx, Sx or Cx processors. This feature provides software an interface to easily read and modify internal control registers.

Each memory-mapped, 32-bit register is accessed via regular memory-format instructions. The processor ensures that these accesses do not generate external bus cycles.

# 2.2.9 Instructions, Data Types and Memory Addressing Modes

As with all 80960 family processors, the 80960RP 33/5.0 instruction set supports several different data types and formats:

- Bit
- · Bit fields
- Integer (8-, 16-, 32-, 64-bit)
- Ordinal (8-, 16-, 32-, 64-bit unsigned integers)
- Triple word (96 bits)
- · Quad word (128 bits)

The 80960RP 33/5.0 provides a full set of addressing modes for C and assembly:

- · Two Absolute modes
- · Five Register Indirect modes
- · Index with displacement mode
- · IP with displacement mode

Table 2 shows the available instructions.



Table 2. 80960RP 33/5.0 Instruction Set



### 3.0 PACKAGE INFORMATION

# 3.1 Package Introduction

The i960<sup>®</sup> RP I/O Processor at 5 Volts is offered in a SuperBGA\* Ball Grid Array (HL-PBGA) package. This is a perimeter array package with four rows of ball connections in the outer area of the package. See Figure 4, 352L HL-PBGA Package Diagram (Bottom View) (pg. 22).

**Section 3.1.1, Functional Signal Definitions** describes signal function; Section 3.1.2, 352-Lead HL-PBGA Package (pg. 21) defines the signal and ball locations.

#### 3.1.1 Functional Signal Definitions

Table 3 presents the legend for interpreting the Type Field in the following tables. Table 4 defines signals associated with the bus interface. Table 5 defines signals associated with basic control and test functions. Table 6 defines signals associated with the Interrupt Unit. Table 7 defines PCI signals. Table 8 defines Memory Controller signals. Table 9 defines DMA, APIC and I<sup>2</sup>C signals. Table 10 defines clock signals. Table 11 defines ICE signals.

**Table 3. Signal Type Definition** 

Symbol	Description				
ı	Input signal only.				
0	Output signal only.				
I/O	Signal can be either an input or output.				
OD	Open Drain signal.				
_	Signal must be connected as described.				
S ()	Synchronous. Inputs must meet setup and hold times relative to S_CLK.				
	S(E) Edge sensitive input S(L) Level sensitive input				
A ()	Asynchronous. Inputs may be asynchronous relative to S_CLK.				
	A(E) Edge sensitive input A(L) Level sensitive input				
R ()	While the P_RST# signal is asserted, the signal:				
	R(1) is driven to $V_{CC}$ R(0) is driven to $V_{SS}$ R(Q) is a valid output R(Z) Floats R(H) is pulled up to $V_{CC}$ R(X) is driven to an unknown state				
H ()	While the 80960RP 33/5.0 is in the hostate, the signal:				
	$\begin{array}{l} H(1) \text{ is driven to V}_{CC} \\ H(0) \text{ is driven to V}_{SS} \\ H(Q) \text{ Maintains previous state or} \\ \text{continues to be a valid output} \\ H(Z) \text{ Floats} \end{array}$				
P ()	While the 80960RP 33/5.0 is halted, the signal:				
	P(1) is driven to V <sub>CC</sub> P(0) is driven to V <sub>SS</sub> P(Q) Maintains previous state or continues to be a valid output				
K ()	While the Secondary PCI Bus is being parked, the signal:				
	K(Z) Floats K(Q) Maintains previous state or continues to be a valid output				



Table 4. Signal Descriptions (Sheet 1 of 5)

NAME	TYPE	DESCRIPTION			
AD31:0	I/O S(L) R(Z) H(Z) P(Q)	ADDRESS / DATA BUS carries 32-bit physical addresses and 8-, 16- or 32-bit data to and from memory. During an address ( $T_a$ ) cycle, bits 2-31 contain a physical word address (bits 0-1 indicate SIZE; see below). During a data ( $T_d$ ) cycle, read or write data is present on one or more contiguous bytes, comprising AD31:24, AD23:16, AD15:8 and AD7:0. During write operations, unused signals are driven to determinate values.			
				s bits 0-1 of the AD lines during a T <sub>a</sub> cycle, specifies nsfers during the bus transaction on the local bus.	
			When the DMA or ATUs initiate data transfers, transfer size shown below is <b>not</b> valid.		
		AD1	AD0	Bus Transfers	
		0 0 1 1	0 1 0 1	1 Transfer 2 Transfers 3 Transfers 4 Transfers	
		When the was:	e 80960RP 33	8/5.0 enters Halt mode and the previous bus operation	
		• write -	- AD31:2 are	driven with the last data value on the AD bus.	
		• read —	- AD31:2 are	driven with the last address value on the AD bus.	
				et the SIZE information of the last bus transaction in or load/store) that was executed before entering Halt	
ADS#	O R(1) H(Z) P(1)	ADDRESS STROBE indicates a valid address and the start of a new bus access. The processor asserts ADS# for the entire $T_a$ cycle. External bus control logic typically samples ADS# at the end of the cycle.			
ALE	O R(0) H(Z) P(0)	<b>ADDRESS LATCH ENABLE</b> indicates the transfer of a physical address. ALE is asserted during a $T_a$ cycle and deasserted before the beginning of the $T_d$ state. It is active HIGH and floats to a high impedance state during a hold cycle $(T_h)$ .			
BLAST#	O R(1) H(Z) P(1)	BURST LAST indicates the last transfer in a bus access. BLAST# is asserted in the last data transfer of burst and non-burst accesses. BLAST# remains active while wait states are detected via the LRDYRCV# or RDYRCV# signal on the memory controller. BLAST# becomes inactive afte the final data transfer in a bus cycle. BLAST# has a weak internal pullup which is active during reset to ensure normal operation when the signal is not connected.  0 = Last Data Transfer 1 = Not the Last Data Transfer			



Table 4. Signal Descriptions (Sheet 2 of 5)

NAME	TYPE	DESCRIPTION
BE3:0#	O R(1) H(Z) P(1)	BYTE ENABLES select which of up to four data bytes on the bus participate in the current bus access. Byte enable encoding depends on the bus width of the memory region accessed:  32-bit bus:  BE3# enables data on AD31:24  BE2# enables data on AD23:16  BE1# enables data on AD15:8  BE0# enables data on AD7:0
		16-bit bus: BE3# becomes Byte High Enable (enables data on AD15:8) BE2# is not used (state is high) BE1# becomes Address Bit 1 (A1) (increments with the assertion of LRDY# or RDYRCV#) BE0# becomes Byte Low Enable (enables data on AD7:0)
		8-bit bus: BE3# is not used (state is high) BE2# is not used (state is high) BE1# becomes Address Bit 1 (A1) (increments with the assertion of LRDY# or RDYRCV#) BE0# becomes Address Bit 0 (A0) (increments with the assertion of LRDY# or RDYRCV#)
		The processor asserts byte enables, byte high enable and byte low enable during $T_a$ . Since unaligned bus requests are split into separate bus transactions, these signals do not toggle during a burst (32-bit bus only) from the i960 core processor; they do toggle for DMA and ATU cycles. They remain active through the last $T_d$ cycle.
DEN#	O R(1) H(Z) P(1)	DATA ENABLE indicates data transfer cycles during a bus access. DEN# is asserted at the start of the first data cycle in a bus access and deasserted at the end of the last data cycle. DEN# is used with DT/R# to provide control for data transceivers connected to the data bus. DEN# has a weak internal pullup which is active during reset to ensure normal operation when the signal is not connected.  0 = Data Cycle
ı		1 = Not a Data Cycle



Table 4. Signal Descriptions (Sheet 3 of 5)

NAME	TYPE	DESCRIPTION
D/C#/ RST_MODE#	<b>I/O</b> R(H) H(Z) P(Q)	DATA/CODE/RESET_MODE indicates that a bus access is a data access or an instruction access. D/C# has the same timing as W/R#.  0 = Instruction Access 1 = Data Access The RST_MODE# signal is sampled at Primary PCI bus reset to determine whether the 20000 are in to be held in react When BST_MODE# in high
		whether the 80960 core is to be held in reset. When RST_MODE# is high, the 80960RP 33/5.0 begins initialization immediately following the deassertion of P_RST. When RST_MODE is low, the 80960 core remains in reset until the 80960 core reset bit is cleared in the extended bridge control register. This signal has a weak internal pullup that is active during reset to ensure normal operation when the signal is left unconnected.
		0 = RST_MODE enabled 1 = RST_MODE not enabled
		While the 80960 core is in reset, all peripherals may be accessed from the primary or secondary PCI buses depending on the status of the WIDTH/HLTD1/RETRY/ signal.
DT/R#	<b>O</b> R(0) H(Z) P(Q)	<b>DATA TRANSMIT / RECEIVE</b> indicates the direction of data transfer to and from the address/data bus. It is low during $T_a$ and $T_w/T_d$ cycles for a read; it is high during $T_a$ and $T_w/T_d$ cycles for a write. DT/R# never changes state when DEN# is asserted.
		0 = Receive 1 = Transmit
LOCK#/ONCE#	<b>I/O</b> S(L) R(H) H(Z) P(Q)	BUS LOCK indicates that an atomic read-modify-write operation is in progress. The LOCK# output is asserted in the first clock of an atomic operation and deasserted in the last data transfer of the sequence. The processor does not grant HOLDA while asserting LOCK#. This prevents external agents from accessing memory involved in semaphore operations.
		0 = Atomic Read-Modify-Write in Progress 1 = No Atomic Read-Modify-Write in Progress
		ONCE MODE: The processor samples the ONCE input during reset. When ONCE# is asserted LOW at the end of reset, the processor enters ONCE mode, stops all clocks and floats all output signals. LOCK#/ONCE# has a weak internal pullup which is active during reset to ensure normal operation when the signal is not connected.
		0 = ONCE Mode Enabled 1 = ONCE Mode Not Enabled
LRDYRCV#	O R(1) H(Q) P(Q)	LOCAL READY/RECOVER, generated by the 80960RP 33/5.0's memory controller unit, is an output version of the READY/RECOVER (RDYRCV#) signal. Refer to the RDYRCV# signal description.



Table 4. Signal Descriptions (Sheet 4 of 5)

NAME	TYPE	DESCRIPTION
HOLD	I S(L)	<b>HOLD</b> is a request from an external bus master to acquire the bus. When the processor receives HOLD and grants bus control to another master, it asserts HOLDA, floats the address/data and control lines and enters the $T_h$ state. When HOLD is deasserted, the processor deasserts HOLDA and enters either the $T_i$ or $T_a$ state, resuming control of the address/data and control lines. See Figure 31, HOLD/HOLDA Waveform For Bus Arbitration (pg. 61). $0 = No \text{ Hold Request}$ $1 = \text{Hold Requested}$
HOLDA	R(0) H(1) P(Q)	HOLD ACKNOWLEDGE indicates to an external bus master that the processor has relinquished bus control. The processor can grant HOLD requests and enter the T <sub>h</sub> state and while halted as well as during regular operation. See Figure 31, HOLD/HOLDA Waveform For Bus Arbitration (pg. 61).  0 = No Hold Acknowledged 1 = Hold Acknowledged
RDYRCV#	I S(L)	<b>READY/RECOVER</b> is only used in systems that use an external memory controller (and do not use the 80960RP 33/5.0's memory controller unit). This signal indicates that data on AD lines can be sampled or removed. When RDYRCV# is not asserted during a $T_d$ cycle, the $T_d$ cycle extends to the next cycle by inserting a wait state ( $T_w$ ). $0 = \text{Sample Data}$ $1 = \text{Do Not Sample Data}$ RDYRCV# has an alternate function during the recovery ( $T_r$ ) state. The processor continues to insert recovery states until it samples the signal HIGH. This gives slow external devices more time to float their buffers before the processor drives addresses. $0 = \text{Insert Wait States}$ $1 = \text{Recovery Complete}$ When using the internal memory controller, connect this signal to $V_{CC}$ through a 2.7 Kohm resistor.
W/R#	<b>O</b> R(0) H(Z) P(Q)	WRITE/READ specifies during a T <sub>a</sub> cycle whether the operation is a write or read. It is latched on-chip and remains valid during T <sub>d</sub> cycles.  0 = Read 1 = Write
WIDTH/ HLTD0	I/O R(H) H(Z) P(Q)	WIDTH denotes the physical memory attributes for a bus transaction in conjunction with WIDTH/HLTD1/RETRY:  WIDTH/HLTD1/RETRY  0 0 8 Bits Wide 0 1 16 Bits Wide 1 0 32 Bits Wide 1 Undefined  WIDTH/HLTD0 has a weak internal pullup which is active during reset to ensure normal operation when the signal is not connected.  HLTD0 signal name has no function in the 80960RP 33/5.0; the signal name
		is included for 80960JF naming convention compatibility.



Table 4. Signal Descriptions (Sheet 5 of 5)

NAME	TYPE	DESCRIPTION
WIDTH/ HLTD1/ RETRY	<b>VO</b> R(H) H(Z) P(Q)	WIDTH denotes the physical memory attributes for a bus transaction in conjunction with the WIDTH/HLTD0 signal. Refer to description above.  RETRY is sampled at Primary PCI bus reset to determine when the Primary PCI interface is disabled. When high, the Primary PCI interface disables PCI configuration cycles by signaling a RETRY until the Extended Bridge Control Register's Configuration Cycle Disable bit is cleared. When low, the Primary PCI interface allows configuration cycles to occur. WIDTH/HLTD1/RETRY has a weak internal pullup which is active during reset to ensure normal operation when the signal is not connected.  HLTD1 signal name has no function in the 80960RP 33/5.0; the signal name is included for 80960JF naming convention compatibility.

Table 5. Power Requirement, Processor Control and Test Signal Descriptions (Sheet 1 of 2)

NAME	TYPE	DESCRIPTION
FAIL#	<b>O</b> R(0) H(Q)	FAIL indicates a failure of the processor's built-in self-test performed during initialization. FAIL# is asserted immediately upon reset and toggles during self-test to indicate the status of individual tests:
	P(1)	When self-test passes, the processor deasserts FAIL# and commences operation from user code.
		When self-test fails, the processor asserts FAIL# and then stops executing. Self-test failing does not cause the bridge to stop execution.
		0 = Self Test Failed 1 = Self Test Passed
L_RST#	0	LOCAL BUS RESET notifies external devices that the local bus has reset.
STEST	I S(L)	SELF TEST enables or disables the processor's internal self-test feature at initialization. STEST is examined at the end of P_RST#. When STEST is asserted, the processor performs its internal self-test and the external bus confidence test. When STEST is deasserted, the processor performs only the external bus confidence test.
		0 = Self Test Disabled 1 = Self Test Enabled
TCK	I	<b>TEST CLOCK</b> is a CPU input that provides the clocking function for IEEE 1149.1 Boundary Scan Testing (JTAG). State information and data are clocked into the processor on the rising edge; data is clocked out of the processor on the falling edge.
TDI	S(L)	<b>TEST DATA INPUT</b> is the serial input signal for JTAG. TDI is sampled on the rising edge of TCK, during the SHIFT-IR and SHIFT-DR states of the Test Access Port. This signal has a weak internal pullup which is active during reset to ensure normal operation when the signal is not connected.
TDO	<b>O</b> R(Q) H(Q) P(Q)	<b>TEST DATA OUTPUT</b> is the serial output signal for JTAG. TDO is driven on the falling edge of TCK during the SHIFT-IR and SHIFT-DR states of the Test Access Port. At other times, TDO floats.



Table 5. Power Requirement, Processor Control and Test Signal Descriptions (Sheet 2 of 2)

NAME	TYPE	DESCRIPTION
TMS	I S(L)	<b>TEST MODE SELECT</b> is sampled at the rising edge of TCK to select the operation of the test logic for IEEE 1149.1 Boundary Scan testing. This signal has a weak internal pullup which is active during reset to ensure normal operation when the signal is not connected.
TRST#	I A(L)	<b>TEST RESET</b> asynchronously resets the Test Access Port (TAP) controller function of IEEE 1149.1 Boundary Scan testing (JTAG). When using the Boundary Scan feature, connect a pulldown resistor (1.5K ohm) between this signal and V <sub>SS</sub> . When TAP is not used, this signal must be connected to V <sub>SS</sub> ; however, no resistor is required. The signal has a weak internal pullup which must be overcome during reset to ensure normal operation.
V <sub>CC</sub>	_	POWER. Connect to a 5.0 Volt V <sub>CC</sub> board plane.
$V_{SS}$	=	<b>GROUND.</b> Connect to a V <sub>SS</sub> board plane.
N.C.	_	NO CONNECT. Do not make electrical connections to these balls.
V <sub>CCPLL</sub> 3:1	I	<b>PLL POWER</b> . For external connection to a 5 V V <sub>CC</sub> board plane. Power to PLLs may require external filtering.

**Table 6. Interrupt Unit Signal Descriptions** 

NAME	TYPE				DESCR	IPTION
NMI#	I A(L)	NMI# is the	highes		upt sour	a non-maskable interrupt event to occur. ce and is level-detect. When NMI# is nect it to $V_{CC}$ .
S_INT[A:D]#/ XINT3:0#	I A(L)	and deasse requesting	ertion is attentio ntil the c	asynchronous n from its devided levice driver cl	to S_C ce drive	equests an interrupt. S_INTx# assertion LK. A device asserts S_INTx# when r. When S_INTx# is asserted, it remains e pending request. S_INTx# Interrupts
			ese sigr	nals operate in		es use this signal to request an interrupt ed mode, where each signal is assigned
		The S_INT	[A:D]#/>	(INT3:0# signa	ıls can b	e directed as follows:
		Sec. PCI		Primary PC	I	80960 Core Processor
		S_INTA#	$\Rightarrow$	P_INTA#	or	XINT0#
		S_INTB#	$\Rightarrow$	P_INTB#	or	XINT1#
		S_INTC#	$\Rightarrow$	P_INTC#	or	XINT2#
		S_INTD#	$\Rightarrow$	P_INTD#	or	XINT3#
XINT7:4#	I A(L)		ese sigr	nals operate in		es use this signal to request an interrupt ed mode, where each signal is assigned



Table 7. PCI Signal Descriptions (Sheet 1 of 3)

NAME	TYPE	DESCRIPTION <sup>1</sup>
P_AD31:0	<b>I/O</b> K(Q) R(Z)	PRIMARY PCI ADDRESS/DATA is the primary multiplexed PCI address and data bus.
P_C/BE3:0#	<b>I/O</b> K(Q) R(Z)	PRIMARY PCI BUS COMMAND and BYTE ENABLE signals are multiplexed on the same PCI signals. During an address phase, P_C/BE3:0# define the bus command. During a data phase, P_C/BE3:0# are used as byte enables.
P_DEVSEL#	<b>I/O</b> K(Z) R(Z)	<b>PRIMARY PCI BUS DEVICE SELECT</b> is driven by a target agent that has successfully decoded the address. As an input, it indicates whether or not an agent has been selected.
P_FRAME#	<b>I/O</b> K(Z) R(Z)	PRIMARY PCI BUS CYCLE FRAME is asserted to indicate the beginning and duration of an access on the Primary PCI bus.
P_GNT#	I R(Z)	PRIMARY PCI BUS GRANT indicates to the agent that access to the bus has been granted. This is a point-to-point signal.
P_IDSEL	S(L)	PRIMARY PCI BUS INITIALIZATION DEVICE SELECT selects the 80960RP 33/5.0 during a Configuration Read or Write command on the primary PCI bus.
P_INT[A:D]#	O OD R(Z)	PRIMARY PCI BUS INTERRUPT requests an interrupt. The assertion and deassertion of P_INTx# is asynchronous to S_CLK. A device asserts its P_INTx# line when requesting attention from its device driver. Once the P_INTx# signal is asserted, it remains asserted until the device driver clears the pending request. P_INTx# Interrupts are level sensitive.
P_IRDY#	<b>I/O</b> K(Z) R(Z)	PRIMARY PCI BUS INITIATOR READY indicates the initiating agent's (bus master's) ability to complete the current data phase of the transaction.
P_LOCK#	I S(L)	<b>PRIMARY PCI BUS LOCK</b> indicates an atomic operation that may require multiple transactions to complete.
P_PAR	<b>I/O</b> K(Q) R(Z)	PRIMARY PCI BUS PARITY. This signal ensures even parity across P_AD31:0 and P_C/BE3:0. All PCI devices must provide a parity signal.
P_PERR#	<b>I/O</b> K(Z) R(Z)	PRIMARY PCI BUS PARITY ERROR is used for reporting data parity errors during all PCI transactions except a special cycle.
P_REQ#	<b>O</b> K(Q) R(Z)	PRIMARY PCI BUS REQUEST indicates to the arbiter that this agent desires use of the bus. This is a point to point signal.



Table 7. PCI Signal Descriptions (Sheet 2 of 3)

NAME	TYPE	DESCRIPTION <sup>1</sup>
P_RST#	I A(L)	PRIMARY RESET brings 80960RP 33/5.0 to a consistent state. When P_RST# is asserted:
		PCI output signals are driven to a known consistent state.
		PCI bus interface output signals are three-stated.
		open drain signals such as P_SERR# are floated.
		S_RST# asserts.
		P_RST# may be asynchronous to S_CLK when asserted or deasserted. Although asynchronous, deassertion must be guaranteed to be a clean, bounce-free edge.
P_SERR#	I/O OD K(Z) R(Z)	PRIMARY PCI BUS SYSTEM ERROR reports address and data parity errors on the special cycle command, or any other system error where the result would be catastrophic.
P_STOP#	<b>I/O</b> K(Z) R(Z)	PRIMARY PCI BUS STOP indicates that the current target is requesting the master to stop the current transaction on the primary PCI bus.
P_TRDY#	<b>I/O</b> K(Z) R(Z)	PRIMARY PCI BUS TARGET READY indicates the target agent's (selected device's) ability to complete the current data phase of the transaction.
S_AD31:0	<b>I/O</b> R(0)	<b>SECONDARY PCI ADDRESS/DATA</b> is the secondary multiplexed PCI address and data bus. A bus transaction consists of an address phase followed by one or more data phases.
S_C/BE3:0#	<b>I/O</b> R(0)	SECONDARY PCI BUS COMMAND and BYTE ENABLE signals are multiplexed on the same PCI signals. During an address phase, S_C/BE3:0# define the bus command. During a data phase, S_C/BE3:0# are used as byte enables.
S_DEVSEL#	<b>I/O</b> R(Z)	SECONDARY PCI BUS DEVICE SELECT is driven by a target agent that has successfully decoded the address. As an input, it indicates whether or not an agent has been selected.
S_FRAME#	<b>I/O</b> R(Z)	SECONDARY PCI BUS CYCLE FRAME is asserted to indicate the beginning and duration of an access on the Secondary PCI bus.
S_GNT0#/ S_REQ#	O R(Z)	SECONDARY PCI BUS GRANT0 is a grant signal sent to device 0 on the secondary PCI bus when the internal Secondary PCI Bus Arbiter is enabled.  SECONDARY PCI BUS REQUEST is the request signal for the 80960RP 33/5.0 when the arbiter is disabled.
S_GNT5:1#	<b>O</b> R(Q)	SECONDARY PCI BUS GRANT are grant signals sent to devices 1-5 on the secondary PCI bus.
S_IDSEL	I S(L)	SECONDARY PCI BUS INITIALIZATION DEVICE SELECT selects the 80960RP 33/5.0 during a Configuration Read or Write command on the secondary PCI bus.



Table 7. PCI Signal Descriptions (Sheet 3 of 3)

NAME	TYPE	DESCRIPTION <sup>1</sup>
S_IRDY#	<b>I/O</b> R(Z)	SECONDARY PCI BUS INITIATOR READY indicates the initiating agent's (bus master's) ability to complete the current data phase of the transaction.
S_LOCK#	<b>I/O</b> R(Z)	<b>SECONDARY PCI BUS LOCK</b> indicates the need to perform an atomic operation on the secondary PCI bus.
S_PAR	<b>I/O</b> R(0)	<b>SECONDARY PCI BUS PARITY.</b> This signal ensures even parity across S_AD31:0 and S_C/BE3:0. All PCI devices must provide a parity signal.
S_PERR#	<b>I/O</b> R(Z)	<b>SECONDARY PCI BUS PARITY ERROR</b> is used for reporting data parity errors during all PCI transactions except a special cycle.
S_REQ0#/ S_GNT#	I	SECONDARY PCI BUS REQUEST0 is a request signal from device 0 on the secondary PCI bus when the internal Secondary PCI Bus Arbiter is enabled.  SECONDARY PCI BUS GRANT is the grant signal for the 80960RP 33/5.0 when the arbiter is disabled.
S_RST#	O R(Q)	<b>SECONDARY PCI BUS RESET</b> is an output based on P_RST#. It brings PCI-specific registers, sequencers, and signals to a consistent state. When P_RST# is asserted, it causes S_RST# to assert, and:
		PCI output signals are driven to a known consistent state.
		PCI bus interface output signals are three-stated.
		open drain signals such as S_SERR# are floated.
		S_RST# may be asynchronous to S_CLK when asserted or deasserted.
S_SERR#	I/O OD R(Z)	<b>SECONDARY PCI BUS SYSTEM ERROR</b> reports address and data parity errors on the special cycle command, or any other system error where the result would be catastrophic.
S_STOP#	<b>I/O</b> R(Z)	SECONDARY PCI BUS STOP indicates that the current target is requesting the master to stop the current transaction on the secondary PCI bus.
S_TRDY#	<b>I/O</b> R(Z)	SECONDARY PCI BUS TARGET READY indicates the target agent's (selected device's) ability to complete the current data phase of the transaction.
S_REQ4:1#	I S(L)	SECONDARY PCI BUS REQUEST 4:1 are request signals from devices 1-4 on the secondary PCI bus.
S_REQ5#/ S_ARB_EN	I S(L)	<b>SECONDARY PCI BUS REQUEST 5</b> is the request signal from device 5 on the secondary PCI bus.
		SECONDARY PCI BUS ARBITER ENABLE defines the power-up status of the internal secondary arbitration unit. A valid high at the deassertion of P_RST# enables the internal secondary arbiter. A valid low at the deassertion of P_RST# disables the internal secondary arbiter.



Table 8. Memory Controller Signal Descriptions (Sheet 1 of 2)

NAME	TYPE	DESCRIPTION
CAS7:0#	<b>O</b> R(1) H(Q)	<b>COLUMN ADDRESS STROBE</b> signals are used for DRAM accesses and are asserted when the MA11:0 signals contain a valid column address. CAS7:0# signals are asserted during refresh.
	P(Q)	Non-Interleaved Operation:           CAS0# = BE0#         lane access           CAS1# = BE1#         lane access           CAS2# = BE2#         lane access           CAS3# = BE3#         lane access
		Interleaved Operation:  CAS0# = BE0# Even leaf lane access CAS1# = BE1# Even leaf lane access
		CAS2# = BE2# Even leaf lane access CAS3# = BE3# Even leaf lane access CAS4# = BE0# Odd leaf lane access CAS5# = BE1# Odd leaf lane access CAS6# = BE2# Odd leaf lane access CAS7# = BE3# Odd leaf lane access
CE1:0#	<b>O</b> R(1) H(Q) P(Q)	CHIP ENABLE signals indicate an access to one of the two SRAM/ FLASH/ ROM memory banks. CE0# and CE1# are never asserted at the same time. These signals are valid during the entire memory operation. CE0# is asserted for accesses to memory bank 0. CE1# is asserted for accesses to memory bank 1.
DALE1:0	O R(0) H(Q) P(Q)	DRAM ADDRESS LATCH ENABLE signals support external address demultiplexing of the MA11:0 address lines for interleaved DRAM systems. Use these to directly interface to '373' type latches. These signals are only valid for accesses to interleaved memory systems. DALE0 is asserted during a valid even leaf address. DALE1 is asserted during a valid odd leaf address.
DP3:0	<b>I/O</b> R(X) H(Q) P(Q)	DATA PARITY carries the parity information for DRAM accesses. Each parity bit corresponds to a group of 8 data bus signals as follows:  DP0 — AD7:0 DP2 — AD23:16 DP1 — AD15:8 DP3 — AD31:24
		The memory controller generates parity information for local bus writes during data cycles. During read data cycles, the memory controller checks parity and provides notification of parity errors on the clock following the data cycle.
		Parity checking and polarity are user-programmable. Parity generation and checking are valid only for data lines that have their associated enable bits asserted.
DWE1:0#	O R(1) H(Q) P(Q)	DRAM WRITE ENABLE signals distinguish between read and write accesses to DRAM. DWE1:0# lines are asserted for writes and deasserted for reads. CAS7:0# determine valid bytes lanes during the access. These two outputs are functionally equivalent for all DRAM accesses; these provide increased drive capability for heavily loaded systems.
LEAF1:0#	0 R(1) H(Q) P(Q)	<b>LEAF ENABLE</b> signals control the data output enables of the memory system during an interleaved DRAM read access. Use these to directly interface to either DRAM or transceiver output enable signals. LEAF0# is asserted during an even leaf access. LEAF1# is asserted during an odd leaf access.



Table 8. Memory Controller Signal Descriptions (Sheet 2 of 2)

NAME	TYPE	DESCRIPTION
MA11:0	O R(X)	MULTIPLEXED ADDRESS signals are multi-purpose depending on the device that is selected.
	H(Q) P(Q)	For memory banks 0 and 1, these signals output address bits A13:2. These address bits are incremented for each data transfer of a burst access.
		For DRAM bank, these signals output the row/column multiplexed address bits 11:0. The relationship between the AD31:0 lines and the MA11:0 lines depends on the bank size, type and arrangement of the DRAM that is accessed.
MWE3:0#	<b>O</b> R(1)	<b>MEMORY WRITE ENABLE</b> signals for write accesses to SRAM/FLASH devices. The MWE's rising edge strobes valid data into these devices.
	H(Q) P(Q)	MWE0# is asserted for writes to the BE0# lane MWE1# is asserted for writes to the BE1# lane MWE2# is asserted for writes to the BE2# lane MWE3# is asserted for writes to the BE3# lane
RAS3:0#	0 R(1) H(Q) P(Q)	ROW ADDRESS STROBE signals are used for DRAM accesses and are asserted when the MA11:0 signals contain a valid row address. RAS3:0# always deasserts after the last data transfer in a DRAM access.
		Non-Interleaved Operation:  RAS0# = Bank0 access  RAS1# = Bank1 access  RAS2# = Bank2 access  RAS3# = Bank3 access
		Interleaved Operation:  RAS0,2# = Bank0 access  RAS1,3# = Bank1 access

Table 9. DMA, APIC, I<sup>2</sup>C Units Signal Descriptions (Sheet 1 of 2)

NAME	TYPE	DESCRIPTION
DACK#	<b>O</b> R(1) H(Q) P(Q)	<b>DMA DEMAND MODE ACKNOWLEDGE</b> The DMA Controller asserts this signal to indicate (1) it can receive new data from an external device or (2) it has data to send to an external device.
DREQ#	S(L)	<b>DMA DEMAND MODE REQUEST</b> External devices use this signal to indicate (1) new data is ready for transfer to the DMA controller or (2) buffers are available to receive data from the DMA controller.
PICCLK	I	APIC BUS CLOCK provides synchronous operation of the APIC bus.
PICD1:0	1/O OD R(Z) H(Q) P(Q)	APIC DATA lines comprise the data portion of the APIC 3-wire bus.



Table 9. DMA, APIC, I<sup>2</sup>C Units Signal Descriptions (Sheet 2 of 2)

NAME	TYPE	DESCRIPTION
SCL	I/O OD R(Z) H(Q) P(Q)	I <sup>2</sup> C CLOCK provides synchronous I <sup>2</sup> C bus operation.
SDA	I/O OD R(Z) H(Q) P(Q)	I <sup>2</sup> C DATA used for data transfer and arbitration on the I <sup>2</sup> C bus.
WAIT#	O R(1) H(Q) P(Q)	WAIT is an output that allows the DMA controller to insert wait states during DMA accesses to an external memory system.

# Table 10. Clock Signal

NAME	TYPE	DESCRIPTION
S_CLK	I	SYNCHRONOUS PCI BUS CLOCK Provides the processor's fundamental time base. All input/output timings are relative to S_CLK.

# Table 11. ICE Signal Descriptions

NAME	TYPE	DESCRIPTION
ICEADS#	0	ICE ADDRESS/DATA STATUS indicates a valid address and the start of a new bus access. ICEADS# is active for accesses to external microcode.
ICEBRK#	ı	ICE BREAK forces the processor to transition from emulation to interrogation mode.
ICEBUS7:0	I/O	ICE BUS is a bidirectional 8-bit bus linking the processor and the emulator. Used in various modes.
ICECLK	0	ICE CLOCK output signal to which all ICE bus signals are synchronized.
ICELOCK#	I	ICE LOCK is sampled during 80960 core reset to protect ICE configuration.
ICEMSG#	I	ICE MESSAGE signal used to acknowledge data from the processor to the emulator. Used only during interrogation mode.
ICESEL#	I	ICESEL enables or disables the ICE unit.
ICEVLD#	0	ICE VALID indicates the processor is driving the ICEBUS with valid data.
MSGFRM#	0	ICE MESSAGE FRAME indicates that trace messages are being issued to the ICEBUS. Used in emulation mode only.



### 3.1.2 352-Lead HL-PBGA Package

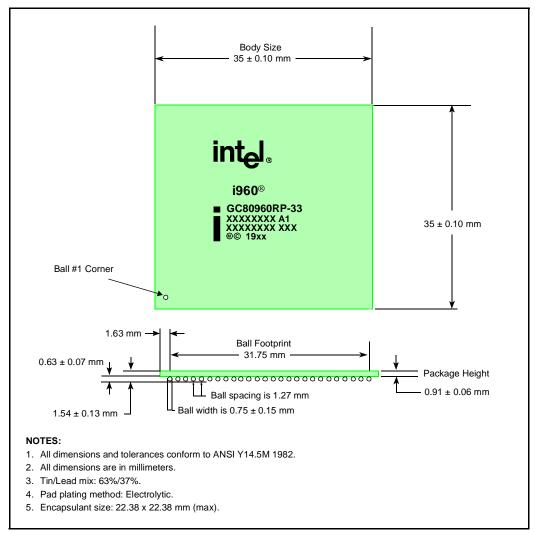


Figure 3. 352L HL-PBGA Package Diagram (Top and Side View)



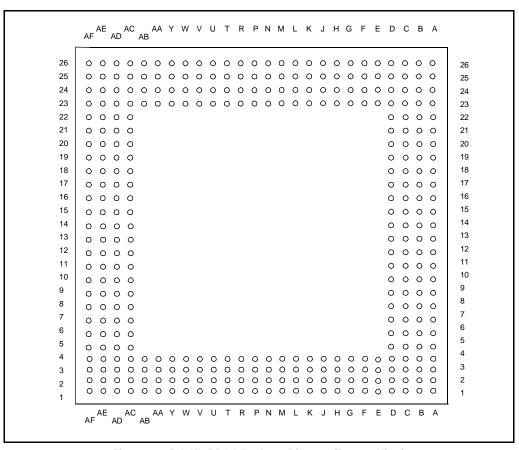


Figure 4. 352L HL-PBGA Package Diagram (Bottom View)



Table 12. 352-Lead HL-PBGA Package — Signal Name Order (Sheet 1 of 4)

Signal   Ball #   CASO#   F1   ICESEL#   AC2					Order (Officer 1 of 4)	1 5 11 2
AD1	Signal	Ball #	Signal Ball #		Signal	Ball #
AD2						
AD3						
AD4						
AD5	AD3	A17	CAS3#	G1	LEAF1	М3
AD6         A16         CAS6#         H1         LRST#         AD6           AD7         B16         CAS7#         H2         MA0         C7           AD8         C15         CE0#         L3         MA1         A7           AD9         A15         CE1#         L1         MA2         B7           AD10         B15         DCM/RST_MODE#         AF4         MA3         C6           AD11         C14         DACK#         AD3         MA4         B6           AD11         C14         DACK#         AD3         MA4         B6           AD12         A14         DALE0         M1         MA5         C5           AD13         B14         DALE0         M1         MA5         C5           AD14         C13         DEN#         A23         MA7         B5           AD14         C13         DEN#         A23         MA7         B6           AD16         B13         DP0         C2         MA8         C4           AD16         B13         DP1         D3         MA9         B4           AD17         C12         DP2         D1         MA1         MM9			CAS4#			
AD7         B16         CAS7#         H2         MA0         C7           AD8         C15         CE0#         L3         MA1         A7           AD9         A15         CE1#         L1         MA2         B7           AD10         B15         D/C#/RST_MODE#         AF4         MA3         C6           AD11         C14         DACK#         AD3         MA4         B6           AD12         A14         DALE0         M1         MA6         A5           AD13         B14         DALE0         M1         MA6         A5           AD14         C13         DALE1         M2         MA6         A5           AD15         A13         DP0         C2         MA8         C4           AD16         B13         DP1         D3         MA9         B4           AD16         B13         DP1         D3         MA9         B4           AD17         C12         DP2         D1         MA10         C3           AD18         A12         DP3         D2         MA11         B3           AD29         C11         AD20         M10         M11         M23 <td< td=""><td>AD5</td><td>C16</td><td>CAS5#</td><td>Н3</td><td>LRDYRCV#</td><td>C19</td></td<>	AD5	C16	CAS5#	Н3	LRDYRCV#	C19
AD8	AD6	A16	CAS6#	H1	LRST#	AD6
AD9	AD7	B16	CAS7#	H2	MA0	C7
AD10         B15         D/C#/RST_MODE#         AF4           AD11         C14           AD12         A14           AD13         B14           AD14         C13           AD15         A13           AD16         B13           AD17         C12           AD18         A12           AD19         B12           AD20         C11           AD21         A11           AD22         B11           AD23         C10           AD24         A10           AD25         B10           AD26         C9           AD27         A9           AD28         B9           AD29         C8           AD31         B8           AD29         C8           AD31         B8           AD33         AB           AD26         C9           ICEBUS2         W1           HOLD         V1           HOLDA         V3           ICEBUS4         AC1           NC         A20           NCBERK#         AA1           NC         A20	AD8	C15	CE0#	L3	MA1	A7
AD11         C14         DACK#         AD3           AD12         A14         DALEO         M1           AD13         B14         DALE1         M2           AD14         C13         DEN#         A23           AD15         A13         DP0         C2           AD16         B13         DP1         D3           AD17         C12         DP2         D1           AD18         A12         DP3         D2           MA18         C4         MA9         B4           AD19         B12         DP2         D1           AD20         C11         DT/R#         B23           AD21         A11         DWE0#         K1           AD22         B11         DWE1#         K2           AD23         C10         FAIL#         AD5           AD24         A10         HOLD         V1           AD25         B10         HOLDA         V3           AD26         C9         ICEADS#         AC1           AD27         A9         ICEBUS         V2           AD28         B9         ICEBUS         V2           AD30         A8	AD9	A15	CE1#	L1	MA2	B7
AD12         A14         DALEO         M1         MA5         C5           AD13         B14         DALE1         M2         MA6         A5           AD14         C13         DEN#         A23         MA7         B5           AD15         A13         DP0         C2         MA8         C4           AD16         B13         DP1         D3         MA9         B4           AD17         C12         DP2         D1         MA10         C3           AD18         A12         DP3         D2         MA11         B3           AD19         B12         DREQ#         AD2         MSGFRM#         AC3           AD20         C11         DT/R#         B23         MWE0#         J3           AD21         A11         DWE0#         K1         MWE0#         J3           AD21         A11         DWE1#         K2         MWE2#         J2           AD23         C10         FAIL#         AD5         MWE3#         K3           AD24         A10         HOLD         V1         NC         A20           AD25         B10         HOLDA         V3         NC         AE4	AD10	B15	D/C#/RST_MODE#	AF4	MA3	C6
AD13         B14         DALE1         M2         MA6         A5           AD14         C13         DEN#         A23         MA7         B5           AD15         A13         DP0         C2         MA8         C4           AD16         B13         DP1         D3         MA9         B4           AD17         C12         DP2         D1         MA10         C3           AD18         A12         DP3         D2         MA11         B3           AD18         A12         DP3         D2         MA11         B3           AD18         A12         DP3         D2         MA11         B3           AD20         C11         DP3         D2         MA11         B3           AD20         C11         DWE0#         K1         MWE0#         J3           AD21         A11         DWE0#         K1         MWE0#         J3           AD22         B11         DWE1#         K2         MWE0#         J3           AD23         C10         FAIL#         AD5         MWE2#         J2           AD26         C3         ICEBUS#         AC1         NC         M20 <td>AD11</td> <td>C14</td> <td>DACK#</td> <td>AD3</td> <td>MA4</td> <td>B6</td>	AD11	C14	DACK#	AD3	MA4	B6
AD14         C13         DEN#         A23         MA7         B5           AD15         A13         DP0         C2         MA8         C4           AD16         B13         DP1         D3         MA9         B4           AD17         C12         DP2         D1         MA10         C3           AD18         A12         DP3         D2         MA11         B3           AD19         B12         DREQ#         AD2         MSGFRM#         AC3           AD20         C11         DT/R#         B23         MWE0#         J3           AD21         A11         DWE0#         K1         MWE1#         J1           AD22         B11         DWE1#         K2         MWE2#         J2           AD23         C10         FAIL#         AD5         MWE3#         K3           AD24         A10         HOLD         V1         NC         A20           AD25         B10         HOLDA         V3         NC         ME4           AD26         C9         ICEBAS#         AC1         NC         B20           AD27         A9         ICEBUS         V2         NMI#         T3 <td>AD12</td> <td>A14</td> <td>DALE0</td> <td>M1</td> <td>MA5</td> <td>C5</td>	AD12	A14	DALE0	M1	MA5	C5
AD15         A13           AD16         B13           AD17         C12           AD18         A12           AD19         B12           AD20         C11           AD21         A11           AD22         B11           AD23         C10           AD24         A10           AD25         B10           AD26         C9           AD27         A9           AD28         B9           AD29         C8           AD31         B8           AD31         B8           AD8#         B21           AD8#         B21           ALE         C20           BE1#         B22           BE2#         C21           BE3#         A21    DP0     C2           MA10         MA11           DWE0#         K1           DWE0#         K1           DWE0#         K1           MWE3#         K3           MWE3#         K3           MVE3#         MWE3#           MWE3#         K3           MC1         NC <td< td=""><td>AD13</td><td>B14</td><td>DALE1</td><td>M2</td><td>MA6</td><td>A5</td></td<>	AD13	B14	DALE1	M2	MA6	A5
AD16         B13         DP1         D3         MA9         B4           AD17         C12         DP2         D1         MA10         C3           AD18         A12         DP3         D2         MA11         B3           AD19         B12         DREQ#         AD2         MSGFRM#         AC3           AD20         C11         DT/R#         B23         MWE0#         J3           AD21         A11         DWE0#         K1         MWE1#         J1           AD22         B11         DWE1#         K2         MWE2#         J2           AD23         C10         FAIL#         AD5         MWE3#         K3           AD24         A10         HOLD         V1         NC         A20           AD25         B10         HOLDA         V3         NC         AE4           AD26         C9         ICEADS#         AC1         NC         B20           AD27         A9         ICEBUS#         AA1         NC         C18           AD28         B9         ICEBUS0         V2         NMI#         T3           AD29         C8         ICEBUS1         W3         P_AD0 <t< td=""><td>AD14</td><td>C13</td><td>DEN#</td><td>A23</td><td>MA7</td><td>B5</td></t<>	AD14	C13	DEN#	A23	MA7	B5
AD17         C12         DP2         D1         MA10         C3           AD18         A12         DP3         D2         MA11         B3           AD20         C11         DTCR#         B23         MSGFRM#         AC3           AD21         A11         DWE0#         K1         MWE0#         J3           AD22         B11         DWE1#         K2         MWE2#         J2           AD23         C10         FAIL#         AD5         MWE3#         K3           AD24         A10         HOLD         V1         NC         A20           AD25         B10         HOLDA         V3         NC         AE4           AD26         C9         ICEADS#         AC1         NC         B20            AD27         A9         ICEBUS#         AA1         NC         C18           AD28         B9         ICEBUS0         V2         NMI#         T3           AD29         C8         ICEBUS1         W3         P_AD0         AD24            AD31         B8         ICEBUS2         W1         P_AD1         AE23           AD2#         ICEBUS5         Y1         P_AD2         AF23 <td>AD15</td> <td>A13</td> <td>DP0</td> <td>C2</td> <td>MA8</td> <td>C4</td>	AD15	A13	DP0	C2	MA8	C4
AD18       A12       DP3       D2       MA11       B3         AD19       B12       DREQ#       AD2       MSGFRM#       AC3         AD20       C11       DT/R#       B23       MWE0#       J3         AD21       A11       DWE0#       K1       MWE1#       J1         AD22       B11       DWE1#       K2       MWE2#       J2         AD23       C10       FAIL#       AD5       MWE3#       K3         AD24       A10       HOLD       V1       NC       A20         AD25       B10       HOLDA       V3       NC       AE4         AD26       C9       ICEADS#       AC1       NC       B20         AD27       A9       ICEBUS#       AA1       NC       C18         AD28       B9       ICEBUS0       V2       NMI#       T3         AD29       C8       ICEBUS0       V2       NMI#       T3         AD31       B8       ICEBUS2       W1       P_AD0       AD24         AD24       AD24       ICEBUS3       W2       P_AD2       AF23         AD25       BE0#       A22       ICEBUS6       Y2       P_AD5	AD16	B13	DP1	D3	MA9	B4
AD19	AD17	C12	DP2	D1	MA10	C3
AD20         C11         DT/R#         B23         MWE0#         J3           AD21         A11         DWE0#         K1         MWE1#         J1           AD22         B11         DWE1#         K2         MWE2#         J2           AD23         C10         FAIL#         AD5         MWE3#         K3           AD24         A10         HOLD         V1         NC         A20           AD25         B10         HOLDA         V3         NC         AE4           AD26         C9         ICEADS#         AC1         NC         B20           AD27         A9         ICEBNS#         AA1         NC         C18           AD28         B9         ICEBUS0         V2         NMI#         T3           AD29         C8         ICEBUS0         V2         NMI#         T3           AD30         A8         ICEBUS1         W3         P_AD0         AD24           AD31         B8         ICEBUS3         W2         P_AD1         AE23           ALE         C20         ICEBUS4         Y3         P_AD2         AF23           BE0#         A22         ICEBUS6         Y2         P_AD5	AD18	A12	DP3	D2	MA11	В3
AD21	AD19	B12	DREQ#	AD2	MSGFRM#	AC3
AD22	AD20	C11	DT/R#	B23	MWE0#	J3
AD23         C10         FAIL#         AD5         MWE3#         K3           AD24         A10         HOLD         V1         NC         A20           AD25         B10         HOLDA         V3         NC         AE4           AD26         C9         ICEADS#         AC1         NC         B20           AD27         A9         ICEBUS#         AA1         NC         C18           AD28         B9         ICEBUS0         V2         NMI#         T3           AD29         C8         ICEBUS0         V2         NMI#         T3           AD30         A8         ICEBUS2         W1         P_AD0         AD24           AD31         B8         ICEBUS3         W2         P_AD1         AE23           ALE         C20         ICEBUS4         Y3         P_AD2         AF23           ALE         C20         ICEBUS5         Y1         P_AD4         AE22           BE1#         B22         ICEBUS7         AA3         P_AD6         AD22           BE2#         C21         ICECLK         AB2         P_AD6         AD22           BE3#         A21         ICELOCK#         AB3	AD21	A11	DWE0#	<b>K</b> 1	MWE1#	J1
AD24         A10         HOLD         V1         NC         A20           AD25         B10         HOLDA         V3         NC         AE4           AD26         C9         ICEADS#         AC1         NC         B20           AD27         A9         ICEBRK#         AA1         NC         C18           AD28         B9         ICEBUS0         V2         NMI#         T3           AD29         C8         ICEBUS1         W3         P_AD0         AD24           AD30         A8         ICEBUS2         W1         P_AD1         AE23           AD31         B8         ICEBUS3         W2         P_AD2         AF23           ALE         C20         ICEBUS4         Y3         P_AD3         AD23           ALE         C20         ICEBUS5         Y1         P_AD4         AE22           BE0#         A22         ICEBUS6         Y2         P_AD5         AF22           BE1#         B22         ICEBUS7         AA3         P_AD6         AD22           BE2#         C21         ICECLK         AB2         P_AD7         AE21           ICELOCK#         AB3         P_AD8         AD21 </td <td>AD22</td> <td>B11</td> <td>DWE1#</td> <td>K2</td> <td>MWE2#</td> <td>J2</td>	AD22	B11	DWE1#	K2	MWE2#	J2
AD25   B10   HOLDA   V3   NC   AE4	AD23	C10	FAIL#	AD5	MWE3#	К3
AD26   C9	AD24	A10	HOLD	V1	NC	A20
AD27	AD25	B10	HOLDA	V3	NC	AE4
AD28         B9         ICEBUS0         V2         NMI#         T3           AD29         C8         ICEBUS1         W3         P_AD0         AD24           AD30         A8         ICEBUS2         W1         P_AD1         AE23           AD31         B8         ICEBUS3         W2         P_AD2         AF23           ADS#         B21         ICEBUS4         Y3         P_AD3         AD23           ALE         C20         ICEBUS5         Y1         P_AD4         AE22           BE0#         A22         ICEBUS6         Y2         P_AD5         AF22           BE1#         B22         ICEBUS7         AA3         P_AD6         AD22           BE2#         C21         ICECLK         AB2         P_AD7         AE21           BE3#         A21         ICELOCK#         AB3         P_AD8         AD21	AD26	C9	ICEADS#	AC1	NC	B20
AD29         C8         ICEBUS1         W3         P_AD0         AD24           AD30         A8         ICEBUS2         W1         P_AD1         AE23           AD31         B8         ICEBUS3         W2         P_AD2         AF23           ADS#         B21         ICEBUS4         Y3         P_AD3         AD23           ALE         C20         ICEBUS5         Y1         P_AD4         AE22           BE0#         A22         ICEBUS6         Y2         P_AD5         AF22           BE1#         B22         ICEBUS7         AA3         P_AD6         AD22           BE2#         C21         ICECLK         AB2         P_AD7         AE21           BE3#         A21         ICELOCK#         AB3         P_AD8         AD21	AD27	A9	ICEBRK#	AA1	NC	C18
AD30	AD28	В9	ICEBUS0	V2	NMI#	Т3
AD31   B8   ICEBUS3   W2   P_AD2   AF23	AD29	C8	ICEBUS1	W3	P_AD0	AD24
ADS#   B21   ICEBUS4   Y3   P_AD3   AD23	AD30	A8	ICEBUS2	W1	P_AD1	AE23
ALE         C20         ICEBUS5         Y1         P_AD4         AE22           BE0#         A22         ICEBUS6         Y2         P_AD5         AF22           BE1#         B22         ICEBUS7         AA3         P_AD6         AD22           BE2#         C21         ICECLK         AB2         P_AD7         AE21           BE3#         A21         ICELOCK#         AB3         P_AD8         AD21	AD31	B8	ICEBUS3	W2	P_AD2	AF23
BE0#         A22         ICEBUS6         Y2         P_AD5         AF22           BE1#         B22         ICEBUS7         AA3         P_AD6         AD22           BE2#         C21         ICECLK         AB2         P_AD7         AE21           BE3#         A21         ICELOCK#         AB3         P_AD8         AD21	ADS#	B21	ICEBUS4	Y3	P_AD3	AD23
BE1#         B22         ICEBUS7         AA3         P_AD6         AD22           BE2#         C21         ICECLK         AB2         P_AD7         AE21           BE3#         A21         ICELOCK#         AB3         P_AD8         AD21	ALE	C20	ICEBUS5	Y1	P_AD4	AE22
BE2#         C21         ICECLK         AB2         P_AD7         AE21           BE3#         A21         ICELOCK#         AB3         P_AD8         AD21	BE0#	A22	ICEBUS6	Y2	P_AD5	AF22
BE3# A21 ICELOCK# AB3 P_AD8 AD21	BE1#	B22	ICEBUS7	AA3	P_AD6	AD22
	BE2#	C21	ICECLK	AB2	P_AD7	AE21
BLAST# C23 ICEMSG# AA2 P_AD9 AE20	BE3#	A21	ICELOCK#	AB3	P_AD8	AD21
	BLAST#	C23	ICEMSG#	AA2	P_AD9	AE20



Table 12. 352-Lead HL-PBGA Package — Signal Name Order (Sheet 2 of 4)

Signal         Ball # P_AD10         Signal P_RST#         Ball # Signal         Signal P_RST#         Ball # S_AD27         S_AD27         K24           P_AD11         AD20 P_AD12         AE19 P_AD13         P_SER#         AE17 AE16         S_AD29         K25 S_AD29         K25 K26           P_AD13         AF19 P_AD14         AD19 P_CCLK         U3 S_AD30         J24 S_AD30         J24 S_AD30 <th>Table 12</th> <th>. 352-Lead</th> <th>HL-PBGA Package — Sig</th> <th>gnai Name</th> <th>Order (Sneet 2 of 4)</th> <th></th>	Table 12	. 352-Lead	HL-PBGA Package — Sig	gnai Name	Order (Sneet 2 of 4)	
P_AD11         AD20         P_SERR#         AE17           P_AD12         AE19         P_STOP#         AE16           P_AD13         AF19         P_TRDY#         AD16           P_AD14         AD19         PICCLK         U3           P_AD15         AE18         PICD0         T1           P_AD16         AE14         PICD1         T2         S_C/BE0#         AA24           P_AD17         AF14         RAS0#         E3         S_C/BE3#         M25           P_AD18         AD14         RAS1#         E1         S_C/BE3#         M25           P_AD19         AE13         RAS2#         E2         S_C/BE3#         M25           P_AD20         AF13         RAS3#         F3         S_C/BE3#         M25           P_AD20         AF13         RAS3#         F3         S_C/BE3#         M25           S_DAD2         AE19         RAS3#         F3         S_C/BE3#         M26           P_AD20         AF13         RAS3#         F3         S_C/BE3#         M25           S_DAD2         AE19         RAS3#         F3         S_CLK         F25           S_DAD2         AE12         S_AD1         AD25 <td>Signal</td> <td>Ball #</td> <td colspan="2">Signal Ball #</td> <td>Signal</td> <td>Ball #</td>	Signal	Ball #	Signal Ball #		Signal	Ball #
P_AD12         AE19         P_STOP#         AE16           P_AD13         AF19         P_TRDY#         AD16           P_AD14         AD19         PICCLK         U3           P_AD15         AE18         PICD0         T1           P_AD16         AE14         PICD1         T2           P_AD16         AE14         PICD1         T2           P_AD17         AF14         RAS0#         E3           P_AD18         AD14         RAS1#         E1         S_C/BE1#         V24           P_AD19         AE13         RAS2#         E2         S_C/BE3#         M25           P_AD20         AF13         RAS3#         F3         S_DEVSEL#         R26           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD22         AE12         S_AD0         AE24         S_GNT0#S_REQ#         H26           P_AD23         AF12         S_AD1         AD25         S_GNT3#         F26	P_AD10	AF20	P_RST#	AE7	S_AD27	K24
P_AD13         AF19         P_TRDY#         AD16           P_AD14         AD19         PICCLK         U3           P_AD15         AE18         PICD0         T1           P_AD16         AE14         PICD1         T2         S_C/BE0#         AA24           P_AD17         AF14         RAS0#         E3         S_C/BE1#         V24           P_AD18         AD14         RAS1#         E1         S_C/BE2#         R26           P_AD19         AE13         RAS2#         E2         S_C/BE3#         M25           P_AD20         AF13         RAS3#         F3         RS_C/BE3#         M25           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD22         AE12         S_AD0         AE24         S_GNT0#S_REQ#         H26           P_AD23         AF12         S_AD1         AD25         S_GNT3#         F26           P_AD24         AF11         S_AD2         AC24         S_GNT3#         F26           P_AD25         AD11         S_AD3         AC26         S_GNT3#         F26	P_AD11	AD20	P_SERR#	AE17	S_AD28	K26
P_AD14         AD19         PICCLK         U3         S_AD31         J26           P_AD15         AE18         PICD0         T1         S_C/BE0#         AA24           P_AD16         AE14         PICD1         T2         S_C/BE0#         AA24           P_AD16         AE14         PICD1         T2         S_C/BE3#         A24           P_AD18         AD14         RAS0#         E3         S_C/BE3#         M25           P_AD19         AE13         RAS1#         E1         S_C/BE3#         M25           P_AD20         AF13         RAS3#         F3         S_DEVSEL#         T24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD22         AE12         S_AD0         AE24         S_GNT0#/S_REQ#         H26           P_AD23         AF12         S_AD1         AD25         S_GNT1#         G24           P_AD24         AF11         S_AD2         AC24         S_GNT2#         G25           P_AD25         AD11         S_AD3         AC26         S_GNT3#         F26           P_AD27         AF10         S_AD6         AB24         S_GNT5#         D24	P_AD12	AE19	P_STOP#	AE16	S_AD29	K25
P_AD15         AE18         PICD0         T1         S_C/BE0#         AA24           P_AD16         AE14         PICD1         T2         S_C/BE1#         V24           P_AD17         AF14         RAS0#         E3         S_C/BE2#         R26           P_AD18         AD14         RAS1#         E1         S_C/BE3#         M25           P_AD19         AE13         RAS2#         E2         S_CIBE3#         M25           P_AD20         AF13         RAS3#         F3         S_DEVSEL#         T24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD22         AE12         S_AD0         AE24         S_GNT0#/S_REQ#         H26           P_AD23         AF12         S_AD0         AE24         S_GNT0#/S_REQ#         H26           P_AD23         AF12         S_AD1         AD25         S_GNT2#         G25           P_AD25         AD11         S_AD2         AC24         S_GNT3#         F26           P_AD26         AE10         S_AD4         AC25         S_GNT3#         F26           P_AD27         AF10         S_AD6         AB26         S_INT4/XINT0#         N1	P_AD13	AF19	P_TRDY#	AD16	S_AD30	J24
P_AD16         AE14         P_AD17         AF14         RAS0#         E3         S_C/BE2#         R26           P_AD18         AD14         RAS1#         E1         S_C/BE2#         R26           P_AD19         AE13         RAS1#         E1         S_C/BE3#         M25           P_AD20         AF13         RAS3#         F3         S_DEVSEL#         T24           P_AD21         AD13         RAS3#         F3         S_DEVSEL#         T24           P_AD21         AD13         RAS3#         F3         S_DEVSEL#         T24           P_AD22         AE12         S_AD0         AE24         S_GNT0#SEQ#         H26           P_AD23         AF12         S_AD1         AD25         S_GNT1#         G24           P_AD24         AF11         S_AD2         AC24         S_GNT3#         F26           P_AD25         AD11         S_AD3         AC26         S_GNT3#         F26           P_AD26         AE10         S_AD4         AC25         S_GNT4#         E26           P_AD27         AF10         S_AD6         AB26         S_INT5#INT10*         N1         N1           P_AD29         AE9         S_AD7         AB25	P_AD14	AD19	PICCLK	U3	S_AD31	J26
P_AD17         AF14         RAS0#         E3         S_C/BE2#         R26           P_AD18         AD14         RAS1#         E1         S_C/BE3#         M25           P_AD19         AE13         RAS2#         E2         S_CLK         F25           P_AD20         AF13         RDYRCV#         B19         S_FRAME#         R24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD22         AE12         S_AD0         AE24         S_GNT0#/S_REQ#         H26           P_AD23         AF12         S_AD1         AD25         S_GNT1#         G24           P_AD24         AF11         S_AD2         AC24         S_GNT2#         G25           P_AD25         AD11         S_AD3         AC26         S_GNT3#         F26           P_AD26         AE10         S_AD4         AC25         S_GNT4#         E26           P_AD27         AF10         S_AD5         AB24         S_GNT5#         D24           P_AD29         AE9         S_AD6         AB26         S_INTA#/XINT0#         N1           P_AD29         AE9         S_AD8         AA26         S_INTB#/XINT1#         N2	P_AD15	AE18	PICD0	T1	S_C/BE0#	AA24
P_AD18         AD14         RAS1#         E1         S_C/BE3#         M25           P_AD19         AE13         RAS2#         E2         S_CLK         F25           P_AD20         AF13         RAS3#         F3         S_DEVSEL#         T24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD22         AE12         S_AD0         AE24         S_GNT0#/S_REQ#         H26           P_AD23         AF12         S_AD1         AD25         S_GNT1#         G24           P_AD24         AF11         S_AD2         AC24         S_GNT0#/S_REQ#         H26           P_AD25         AD11         S_AD2         AC24         S_GNT0#/S_REQ#         H26           P_AD25         AD11         S_AD3         AC26         S_GNT2#         G25           P_AD26         AE10         S_AD3         AC26         S_GNT3#         F26           P_AD27         AF10         S_AD4         AC25         S_GNT4#         E26           P_AD29         AE9         S_AD5         AB24         S_INTA#/XINT0#         N1         S_INTA#/XINT0#         N1           P_AD30         AF9         S_AD9         AA25 <td>P_AD16</td> <td>AE14</td> <td>PICD1</td> <td>T2</td> <td>S_C/BE1#</td> <td>V24</td>	P_AD16	AE14	PICD1	T2	S_C/BE1#	V24
P_AD19         AE13         RAS2#         E2         S_CLK         F25           P_AD20         AF13         RAS3#         F3         S_DEVSEL#         T24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD22         AE12         S_AD0         AE24         S_GNT0#/S_REQ#         H26           P_AD23         AF12         S_AD1         AD25         S_GNT1#         G24           P_AD24         AF11         S_AD2         AC24         S_GNT2#         G25           P_AD25         AD11         S_AD3         AC26         S_GNT3#         F26           P_AD26         AE10         S_AD4         AC25         S_GNT3#         F26           P_AD27         AF10         S_AD5         AB24         S_GNT3#         F26           P_AD28         AD10         S_AD6         AB26         S_INT8#/XINT0#         N1           P_AD30         AF9         S_AD8         AA26         S_INTA#/XINT0#         N1           P_C/BE0#         AF21         S_AD10         Y24         S_INTB#/XINT1#         N2           P_C/BE1#         AF18         S_AD10         Y24         S_INTB#/XINT3#         P1	P_AD17	AF14	RAS0#	E3	S_C/BE2#	R26
P_AD20         AF13         RAS3#         F3         S_DEVSEL#         T24           P_AD21         AD13         RDYRCV#         B19         S_FRAME#         R24           P_AD22         AE12         S_AD0         AE24         S_GNT0#/S_REQ#         H26           P_AD23         AF11         S_AD2         AC24         S_GNT0#/S_REQ#         H26           P_AD24         AF11         S_AD2         AC24         S_GNT0#/S_REQ#         H26           P_AD24         AF11         S_AD2         AC24         S_GNT0#/S_REQ#         H26           P_AD25         AD11         S_AD2         AC24         S_GNT1#         G24           P_AD25         AD11         S_AD3         AC26         S_GNT2#         G25           P_AD26         AE10         S_AD4         AC25         S_GNT3#         F26           P_AD27         AF10         S_AD5         AB24         S_GNT5#         D24           P_AD28         AD10         S_AD6         AB26         S_IDSEL         M26           P_AD29         AE9         S_AD7         AB25         S_INTB#/XINT0#         N1           P_AD30         AF9         S_AD9         AA26         S_INTB#/XINT1#	P_AD18	AD14	RAS1#	E1	S_C/BE3#	M25
P_AD21         AD13           P_AD22         AE12           P_AD23         AF12           P_AD24         AF11           P_AD25         AD11           P_AD26         AE10           P_AD27         AF10           P_AD28         AD10           P_AD29         AE9           P_AD30         AF9           P_C/BE0#         AF21           P_C/BE2#         AD15           P_C/BE3#         AE11           P_CBC8E4#         AF16           P_CRESH         AF16           P_CRESH         AF16           P_CRESH         AF18           P_CRESH         AF18           P_CRESH         AF16           S_AD13         W24           S_PAR         V26	P_AD19	AE13	RAS2#	E2	S_CLK	F25
P_AD22         AE12         S_AD0         AE24           P_AD23         AF12         S_AD1         AD25           P_AD24         AF11         S_AD2         AC24           P_AD25         AD11         S_AD3         AC26           P_AD26         AE10         S_AD4         AC25           P_AD27         AF10         S_AD5         AB24           P_AD28         AD10         S_AD6         AB26           P_AD29         AE9         S_AD7         AB25           P_AD30         AF9         S_AD8         AA26           P_AD31         AD9         S_AD9         AA25           P_C/BE0#         AF21         S_AD10         Y24           P_C/BE1#         AF18         S_AD11         Y26           P_C/BE2#         AD15         S_AD12         Y25           P_C/BE3#         AE11         S_AD13         W24           P_FRAME#         AF15         S_AD14         W26           P_FRAME#         AF15         S_AD16         R25           P_INTA#         AF6         S_AD16         R25           P_INTA#         AF6         S_AD16         R25           P_INTB#         AE6	P_AD20	AF13	RAS3#	F3	S_DEVSEL#	T24
P_AD23         AF12           P_AD24         AF11           P_AD25         AD11           P_AD26         AE10           P_AD27         AF10           P_AD28         AD10           P_AD29         AE9           P_AD30         AF9           P_AD31         AD9           P_C/BE0#         AF21           P_C/BE1#         AF18           P_C/BE2#         AD15           P_C/BE3#         AE11           P_DEVSEL#         AF16           P_BRAME#         AF15           P_IDSEL         AD12           P_INTA#         AF6           P_INTB#         AE6           P_INTB#         AE6           P_INTC#         AD7	P_AD21	AD13	RDYRCV#	B19	S_FRAME#	R24
P_AD24         AF11         S_AD2         AC24         S_GNT2#         G25           P_AD25         AD11         S_AD3         AC26         S_GNT3#         F26           P_AD26         AE10         S_AD5         AB24         S_GNT3#         F26           P_AD27         AF10         S_AD5         AB24         S_GNT5#         D24           P_AD28         AD10         S_AD6         AB26         S_GNT5#         D24           P_AD29         AE9         S_AD6         AB26         S_IDSEL         M26           P_AD30         AF9         S_AD8         AA26         S_INTA#/XINT0#         N1           P_AD31         AD9         S_AD9         AA25         S_INTB#/XINT1#         N2           P_C/BE0#         AF21         S_AD10         Y24         S_INTD#/XINT3#         P1           P_C/BE1#         AF18         S_AD11         Y26         S_INTD#/XINT3#         P1           P_C/BE2#         AD15         S_AD12         Y25         S_LOCK#         U26           P_C/BE3#         AE11         S_AD13         W24         S_PAR         V26           P_CRE3#         AE16         S_AD15         W25         S_REQ0#/S_GNT#	P_AD22	AE12	S_AD0	AE24	S_GNT0#/S_REQ#	H26
P_AD25         AD11           P_AD26         AE10           P_AD27         AF10           P_AD28         AD10           P_AD29         AE9           P_AD30         AF9           P_C/BE0#         AF21           P_C/BE1#         AF18           P_C/BE2#         AD15           P_C/BE3#         AE11           P_CRBCW         AF16           P_CRBCW         AF16           P_CRBCW         AF16           P_CRBCW         AF17           P_CRBCW         AD15           P_CRBCW         AD16           P_CRBCW         AP16	P_AD23	AF12	S_AD1	AD25	S_GNT1#	G24
P_AD26         AE10           P_AD27         AF10           P_AD28         AD10           P_AD29         AE9           P_AD30         AF9           P_AD31         AD9           P_C/BE0#         AF21           P_C/BE1#         AF18           P_C/BE2#         AD15           P_C/BE3#         AE11           P_FRAME#         AF15           P_GNT#         AF8           P_IDSEL         AD12           P_INTA#         AE6           P_INTB#         AE6           P_INTC#         AD7           S_AD2         AB26           S_AD7         AB25           S_INTA#/XINT0#         N1           S_INTB#/XINT1#         N2           S_INTD#/XINT3#         P1           S_INTD#/XINT3#         P1           S_INDP#/XINT3#         P1           S_INDP#/XINT3#         P1           S_INDP#/XINT3#         P1           S_INDC#/XINT3#         P1           S_INDE#/XINT3#         P1           S_INDE#/XINT3#         P1           S_INDE#/XINT3#         P1           S_INDE#/XINT3#         P1	P_AD24	AF11	S_AD2	AC24	S_GNT2#	G25
P_AD27         AF10         S_AD5         AB24         S_GNT5#         D24           P_AD28         AD10         S_AD6         AB26         S_IDSEL         M26           P_AD29         AE9         S_AD7         AB25         S_INTA#/XINT0#         N1           P_AD30         AF9         S_AD8         AA26         S_INTB#/XINT1#         N2           P_AD31         AD9         S_AD9         AA25         S_INTC#/XINT2#         P3           P_C/BE0#         AF21         S_AD10         Y24         S_INTD#/XINT3#         P1           P_C/BE1#         AF18         S_AD11         Y26         S_IRDY#         T25           P_C/BE2#         AD15         S_AD12         Y25         S_LOCK#         U26           P_C/BE3#         AE11         S_AD13         W24         S_PAR         V26           P_DEVSEL#         AF16         S_AD14         W26         S_PERR#         U24           P_FRAME#         AF15         S_AD15         W25         S_REQ0#/S_GNT#         H24           P_GNT#         AF8         S_AD16         R25         S_REQ1#         S_REQ1#         H25           P_INTA#         AF6         S_AD18         P26         <	P_AD25	AD11	S_AD3	AC26	S_GNT3#	F26
P_AD28         AD10         S_AD6         AB26         S_IDSEL         M26           P_AD29         AE9         S_AD7         AB25         S_INTA#/XINT0#         N1           P_AD30         AF9         S_AD8         AA26         S_INTB#/XINT1#         N2           P_AD31         AD9         S_AD9         AA25         S_INTC#/XINT2#         P3           P_C/BE0#         AF21         S_AD10         Y24         S_INTD#/XINT3#         P1           P_C/BE1#         AF18         S_AD11         Y26         S_IRDY#         T25           P_C/BE2#         AD15         S_AD12         Y25         S_LOCK#         U26           P_C/BE3#         AE11         S_AD13         W24         S_PAR         V26           P_DEVSEL#         AF16         S_AD13         W24         S_PERR#         U24           P_FRAME#         AF15         S_AD15         W25         S_REQ0#/S_GNT#         H24           P_IDSEL         AD12         S_AD16         R25         S_REQ1#         S_REQ2#         G26           P_INTA#         AF6         S_AD18         P26         S_REQ3#         F24           P_INTB#         AE6         S_AD20         N24	P_AD26	AE10	S_AD4	AC25	S_GNT4#	E26
P_AD29         AE9           P_AD30         AF9           P_AD31         AD9           P_C/BE0#         AF21           P_C/BE1#         AF18           P_C/BE2#         AD15           P_C/BE3#         AE11           P_DEVSEL#         AF16           P_GNT#         AF8           P_IDSEL         AD12           P_INTA#         AF6           P_INTB#         AE6           P_INTC#         AD7           S_AD2         S_INTA#/XINT0#           S_INTB#/XINT1#         N2           S_INTB#/XINT1#         N2           S_INTD#/XINT3#         P1           S_INDY#         T25           S_INDY#         T25           S_INDY#         T25           S_INDY#         T25           S_INDY#         T25           S_INDY#         T25	P_AD27	AF10	S_AD5	AB24	S_GNT5#	D24
P_AD30         AF9           P_AD31         AD9           P_C/BE0#         AF21           P_C/BE1#         AF18           P_C/BE2#         AD15           P_C/BE3#         AE11           P_DEVSEL#         AF16           P_GNT#         AF8           P_IDSEL         AD12           P_INTA#         AF6           P_INTB#         AE6           P_INTC#         AD7           S_AD8         AA26           S_INTB#/XINT1#         N2           S_INTB#/XINT1#         N2           S_INTD#/XINT3#         P1           S_INTD#/XINT3#         P1           S_INTD#/XINT3#         P1           S_IRDY#         T25           S_IRDY#         T25           S_IRDY#         T25           S_INTD#/XINT3#         P1           S_IRDY#         T25           S_IRDY#         T25<	P_AD28	AD10	S_AD6	AB26	S_IDSEL	M26
P_AD31         AD9           P_C/BE0#         AF21           P_C/BE1#         AF18           P_C/BE2#         AD15           P_C/BE3#         AE11           P_DEVSEL#         AF16           P_FRAME#         AF15           P_GNT#         AF8           P_IDSEL         AD12           P_INTA#         AF6           P_INTB#         AE6           P_INTC#         AD7           S_AD9         AA25           S_INTC#/XINT2#         P3           S_INTD#/XINT3#         P1           S_IRDY#         T25           S_IRDY#         T25           S_LOCK#         U26           S_PAR         V26           S_PAR         V26           S_PERR#         U24           S_PERR#         U24           S_REQ0#/S_GNT#         H24           S_REQ0#/S_GNT#         H25           S_AD16         R25           S_REQ1#         H25           S_REQ2#         G26           S_REQ3#         F24           S_REQ4#         E24           S_REQ5#/S_ARB_EN         E25	P_AD29	AE9	S_AD7	AB25	S_INTA#/XINT0#	N1
P_C/BE0#         AF21           P_C/BE1#         AF18           P_C/BE2#         AD15           P_C/BE3#         AE11           P_DEVSEL#         AF16           P_FRAME#         AF15           P_GNT#         AF8           P_IDSEL         AD12           P_INTA#         AF6           P_INTB#         AE6           P_INTC#         AD7           S_AD10         Y24           S_INTD#/XINT3#         P1           S_IRDY#         T25	P_AD30	AF9	S_AD8	AA26	S_INTB#/XINT1#	N2
P_C/BE1#         AF18           P_C/BE2#         AD15           P_C/BE3#         AE11           P_DEVSEL#         AF16           P_FRAME#         AF15           P_GNT#         AF8           P_IDSEL         AD12           P_INTA#         AF6           P_INTB#         AE6           P_INTC#         AD7           S_AD11         Y26           S_IRDY#         T25           S_LOCK#         U26           S_PAR         V26           S_PERR#         U24           S_REQ0#/S_GNT#         H24           S_REQ0#/S_GNT#         H24           S_REQ1#         H25           S_REQ2#         G26           S_REQ2#         G26           S_REQ3#         F24           S_REQ3#         F24           S_REQ4#         E24           S_REQ5#/S_ARB_EN         E25	P_AD31	AD9	S_AD9	AA25	S_INTC#/XINT2#	P3
P_C/BE2#         AD15           P_C/BE3#         AE11           P_DEVSEL#         AF16           P_FRAME#         AF15           P_GNT#         AF8           P_IDSEL         AD12           P_INTA#         AF6           P_INTB#         AE6           P_INTC#         AD7           S_AD12         Y25           S_LOCK#         U26           S_PAR         V26           S_PERR#         U24           S_REQ0#/S_GNT#         H24           S_REQ0#/S_GNT#         H25           S_REQ1#         H25           S_REQ1#         H25           S_REQ2#         G26           S_REQ3#         F24           S_REQ3#         F24           S_REQ4#         E24           S_REQ5#/S_ARB_EN         E25	P_C/BE0#	AF21	S_AD10	Y24	S_INTD#/XINT3#	P1
P_C/BE3#         AE11         S_AD13         W24         S_PAR         V26           P_DEVSEL#         AF16         S_AD14         W26         S_PERR#         U24           P_FRAME#         AF15         S_AD15         W25         S_REQ0#/S_GNT#         H24           P_GNT#         AF8         S_AD16         R25         S_REQ1#         H25           P_INTSEL         AD12         S_AD17         P24         S_REQ2#         G26           P_INTA#         AF6         S_AD18         P26         S_REQ3#         F24           P_INTB#         AE6         S_AD19         P25         S_REQ4#         E24           P_INTC#         AD7         S_AD20         N24         S_REQ5#/S_ARB_EN         E25	P_C/BE1#	AF18	S_AD11	Y26	S_IRDY#	T25
P_DEVSEL#         AF16         S_AD14         W26         S_PERR#         U24           P_FRAME#         AF15         S_AD15         W25         S_REQ0#/S_GNT#         H24           P_GNT#         AF8         S_AD16         R25         S_REQ1#         H25           P_IDSEL         AD12         S_AD17         P24         S_REQ2#         G26           P_INTA#         AF6         S_AD18         P26         S_REQ3#         F24           P_INTB#         AE6         S_AD19         P25         S_REQ4#         E24           P_INTC#         AD7         S_AD20         N24         S_REQ5#/S_ARB_EN         E25	P_C/BE2#	AD15	S_AD12	Y25	S_LOCK#	U26
P_FRAME#         AF15           P_GNT#         AF8           P_IDSEL         AD12           P_INTA#         AF6           P_INTB#         AE6           P_INTC#         AD7           S_AD15         W25           S_REQ0#/S_GNT#         H24           S_REQ1#         H25           S_REQ2#         G26           S_REQ3#         F24           S_REQ3#         F24           S_REQ4#         E24           S_REQ4#         E24           S_REQ5#/S_ARB_EN         E25	P_C/BE3#	AE11	S_AD13	W24	S_PAR	V26
P_GNT#         AF8         S_AD16         R25         S_REQ1#         H25           P_IDSEL         AD12         S_AD17         P24         S_REQ2#         G26           P_INTA#         AF6         S_AD18         P26         S_REQ3#         F24           P_INTB#         AE6         S_AD19         P25         S_REQ4#         E24           P_INTC#         AD7         S_AD20         N24         S_REQ5#/S_ARB_EN         E25	P_DEVSEL#	AF16	S_AD14	W26	S_PERR#	U24
P_IDSEL         AD12         S_AD17         P24         S_REQ2#         G26           P_INTA#         AF6         S_AD18         P26         S_REQ3#         F24           P_INTB#         AE6         S_AD19         P25         S_REQ4#         E24           P_INTC#         AD7         S_AD20         N24         S_REQ5#/S_ARB_EN         E25	P_FRAME#	AF15	S_AD15	W25	S_REQ0#/S_GNT#	H24
P_INTA#         AF6         S_AD18         P26         S_REQ3#         F24           P_INTB#         AE6         S_AD19         P25         S_REQ4#         E24           P_INTC#         AD7         S_AD20         N24         S_REQ5#/S_ARB_EN         E25	P_GNT#	AF8	S_AD16	R25	S_REQ1#	H25
P_INTB#         AE6         S_AD19         P25         S_REQ4#         E24           P_INTC#         AD7         S_AD20         N24         S_REQ5#/S_ARB_EN         E25	P_IDSEL	AD12	S_AD17	P24	S_REQ2#	G26
P_INTC# AD7 S_AD20 N24 S_REQ5#/S_ARB_EN E25	P_INTA#	AF6	S_AD18	P26	S_REQ3#	F24
	P_INTB#	AE6	S_AD19	P25	S_REQ4#	E24
P INTD#   AF7   S AD21   N26   S RST#   125	P_INTC#	AD7	S_AD20	N24	S_REQ5#/S_ARB_EN	E25
1_1115" A11 0_A521 1420 0_101# 323	P_INTD#	AF7	S_AD21	N26	S_RST#	J25
P_IRDY# <b>AE15</b> S_AD22 <b>N25</b> S_SERR# <b>V25</b>	P_IRDY#	AE15	S_AD22	N25	S_SERR#	V25
P_LOCK# <b>AD17</b> S_AD23 <b>M24</b> S_STOP# <b>U25</b>	P_LOCK#	AD17	S_AD23	M24	S_STOP#	U25
P_PAR         AD18         S_AD24         L24         S_TRDY#         T26	P_PAR	AD18	S_AD24	L24	S_TRDY#	T26
P_PERR# <b>AF17</b> S_AD25 <b>L26</b> SCL <b>U1</b>	P_PERR#	AF17			SCL	U1
P_REQ# <b>AE8</b> S_AD26 <b>L25</b> SDA <b>U2</b>	P_REQ#	AE8	S_AD26	L25	SDA	U2



Table 12. 352-Lead HL-PBGA Package — Signal Name Order (Sheet 3 of 4)

Signal	Ball #	Signal	Ball #	Signal	Ball #
STEST	AE3	V <sub>CC</sub>	B2	V <sub>SS</sub>	AC7
TCK	B24	V <sub>CC</sub>	B25	V <sub>SS</sub>	AC9
TDI	D26	V <sub>CC</sub>	B26	V <sub>SS</sub>	AC11
TDO	D25	V <sub>CC</sub>	C1	V <sub>SS</sub>	AC13
TMS	C24	V <sub>CC</sub>	C26	V <sub>SS</sub>	AC15
TRST#	C25	V <sub>CC</sub>	D5	V <sub>SS</sub>	AC17
V <sub>CC</sub>	A1	V <sub>CC</sub>	D7	V <sub>SS</sub>	AC19
V <sub>CC</sub>	A2	V <sub>CC</sub>	D9	V <sub>SS</sub>	AC21
V <sub>CC</sub>	А3	V <sub>CC</sub>	D11	V <sub>SS</sub>	AC23
V <sub>CC</sub>	A24	V <sub>CC</sub>	D13	V <sub>SS</sub>	D4
V <sub>CC</sub>	A25	V <sub>CC</sub>	D15	V <sub>SS</sub>	D6
V <sub>CC</sub>	A26	V <sub>CC</sub>	D17	V <sub>SS</sub>	D8
V <sub>CC</sub>	AA23	V <sub>CC</sub>	D19	V <sub>SS</sub>	D10
V <sub>CC</sub>	AB4	V <sub>CC</sub>	D21	V <sub>SS</sub>	D12
V <sub>CC</sub>	AC6	V <sub>CC</sub>	E23	V <sub>SS</sub>	D14
V <sub>CC</sub>	AC8	V <sub>CC</sub>	F4	V <sub>SS</sub>	D16
V <sub>CC</sub>	AC10	V <sub>CC</sub>	G23	V <sub>SS</sub>	D18
V <sub>CC</sub>	AC12	V <sub>CC</sub>	H4	V <sub>SS</sub>	D20
V <sub>CC</sub>	AC14	V <sub>CC</sub>	J23	V <sub>SS</sub>	D22
V <sub>CC</sub>	AC16	V <sub>CC</sub>	K4	V <sub>SS</sub>	D23
V <sub>CC</sub>	AC18	V <sub>CC</sub>	L23	V <sub>SS</sub>	E4
V <sub>CC</sub>	AC20	V <sub>CC</sub>	M4	V <sub>SS</sub>	F23
V <sub>CC</sub>	AC22	V <sub>CC</sub>	N23	V <sub>SS</sub>	G4
V <sub>CC</sub>	AD1	V <sub>CC</sub>	P4	V <sub>SS</sub>	H23
V <sub>CC</sub> /V <sub>SS</sub> (1)	AD8	V <sub>CC</sub>	R23	V <sub>SS</sub>	J4
V <sub>CC</sub>	AD26	V <sub>CC</sub>	T4	V <sub>SS</sub>	K23
V <sub>CC</sub>	AE1	V <sub>CC</sub>	U23	V <sub>SS</sub>	L4
V <sub>CC</sub>	AE2	V <sub>CC</sub>	V4	V <sub>SS</sub>	M23
V <sub>CC</sub>	AE25	V <sub>CC</sub>	W23	V <sub>SS</sub>	N4
V <sub>CC</sub>	AE26	V <sub>CC</sub>	Y4	V <sub>SS</sub>	P23
V <sub>CC</sub>	AF1	VCCPLL1	A19	V <sub>SS</sub>	R4
V <sub>CC</sub>	AF2	VCCPLL2	A6	V <sub>SS</sub>	T23
V <sub>CC</sub>	AF3	VCCPLL3	A4	V <sub>SS</sub>	U4
V <sub>CC</sub>	AF24	V <sub>SS</sub>	AA4	V <sub>SS</sub>	V23
V <sub>CC</sub>	AF25	V <sub>SS</sub>	AB23	V <sub>SS</sub>	W4
V <sub>CC</sub>	AF26	V <sub>SS</sub>	AC4	V <sub>SS</sub>	Y23
V <sub>CC</sub>	B1	V <sub>SS</sub>	AC5	W/R#	C22

<sup>1.</sup> Ball AD8 must be tied to either  $\rm V_{CC}$  or  $\rm V_{SS}.$ 



Table 12. 352-Lead HL-PBGA Package — Signal Name Order (Sheet 4 of 4)

Signal	Ball #
WAIT#	N3
WIDTH/HLTD0	AF5
WIDTH/HLTD1/RETRY	AE5

Signal	Ball #
XINT4#	P2
XINT5#	R3
XINT6#	R1

Signal	Ball #
XINT7#	R2



Table 13. 352-Lead HL-PBGA Pinout — Ballpad Number Order (Sheet 1 of 4)

Ball #	Signal	
<b>A</b> 1	V <sub>CC</sub>	
A2	V <sub>CC</sub>	
А3	V <sub>CC</sub>	
A4	V <sub>CCPLL3</sub>	
A5	MA6	
A6	V <sub>CCPLL2</sub>	
A7	MA1	
A8	AD30	
A9	AD27	
A10	AD24	
A11	AD21	
A12	AD18	
A13	AD15	
A14	AD12	
A15	AD9	
A16	AD6	
A17	AD3	
A18	AD0	
A19	V <sub>CCPLL1</sub>	
A20	NC	
A21	BE3#	
A22	BE0#	
A23	DEN#	
A24	V <sub>CC</sub>	
A25	V <sub>CC</sub>	
A26	V <sub>CC</sub>	
B1	V <sub>CC</sub>	
B2	V <sub>CC</sub>	
В3	MA11	
B4	MA9	
B5	MA7	
В6	MA4	
B7	MA2	
B8	AD31	
В9	AD28	

Pinout — Ballpad Numb		
Signal		
AD25		
AD22 AD19		
AD13		
AD10		
AD7		
AD4		
AD1		
RDYRCV#		
NC		
ADS#		
BE1#		
DT/R#		
TCK		
V <sub>CC</sub>		
V <sub>CC</sub>		
V <sub>CC</sub>		
DP0		
MA10		
MA8		
MA5		
MA3		
MA0		
AD29		
AD26		
AD23		
AD20		
AD17		
AD14		
AD11		
AD8		
AD5		
AD2		
NC		

Ball #	Signal			
C19	LRDYRCV#			
C20	ALE			
C21	BE2#			
C22	W/R#			
C23	BLAST#			
C24	TMS			
C25	TRST#			
C26	V <sub>CC</sub>			
D1	DP2			
D2	DP3			
D3	DP1			
D4	V <sub>SS</sub>			
D5	V <sub>CC</sub>			
D6	V <sub>SS</sub>			
D7	V <sub>SS</sub> V <sub>CC</sub>			
D8	V <sub>SS</sub>			
D9	V <sub>CC</sub>			
D10	V <sub>SS</sub>			
D11	V <sub>CC</sub>			
D12	V <sub>SS</sub>			
D13	V <sub>CC</sub>			
D14	V <sub>SS</sub>			
D15	V <sub>CC</sub>			
D16	V <sub>SS</sub>			
D17	V <sub>CC</sub>			
D18	$V_{SS}$			
D19	V <sub>CC</sub>			
D20	V <sub>SS</sub>			
D21	V <sub>CC</sub>			
D22	V <sub>SS</sub>			
D23	V <sub>SS</sub>			
D24	S_GNT5#			
D25	TDO			
D26	TDI			
E1	RAS1#			



Table 13. 352-Lead HL-PBGA Pinout — Ballpad Number Order (Sheet 2 of 4)

Ball #	Signal	Ball #	Signal	Ball #	Signal
E2	RAS2#	J23	V <sub>CC</sub>	N26	S_AD21
E3	RAS0#	J24	S_AD30	P1	S_INTD#/XINT3#
E4	V <sub>SS</sub>	J25	S_RST#	P2	XINT4#
E23	V <sub>CC</sub>	J26	S_AD31	P3	S_INTC#/XINT2#
E24	S_REQ4#	K1	DWE0#	P4	V <sub>CC</sub>
E25	S_REQ5#/S_ARB_EN	K2	DWE1#	P23	V <sub>SS</sub>
E26	S_GNT4#	К3	MWE3#	P24	S_AD17
F1	CAS0#	K4	V <sub>CC</sub>	P25	S_AD19
F2	CAS1#	K23	V <sub>SS</sub>	P26	S_AD18
F3	RAS3#	K24	S_AD27	R1	XINT6#
F4	V <sub>CC</sub>	K25	S_AD29	R2	XINT7#
F23	$V_{SS}$	K26	S_AD28	R3	XINT5#
F24	S_REQ3#	L1	CE1#	R4	$V_{SS}$
F25	S_CLK	L2	LEAF0#	R23	V <sub>CC</sub>
F26	S_GNT3#	L3	CE0#	R24	S_FRAME#
G1	CAS3#	L4	$V_{SS}$	R25	S_AD16
G2	CAS4#	L23	V <sub>CC</sub>	R26	S_C/BE2#
G3	CAS2#	L24	S_AD24	T1	PICD0
G4	$V_{SS}$	L25	S_AD26	T2	PICD1
G23	V <sub>CC</sub>	L26	S_AD25	Т3	NMI#
G24	S_GNT1#	M1	DALE0	T4	V <sub>CC</sub>
G25	S_GNT2#	M2	DALE1	T23	V <sub>SS</sub>
G26	S_REQ2#	М3	LEAF1#	T24	S_DEVSEL#
H1	CAS6#	M4	V <sub>CC</sub>	T25	S_IRDY#
H2	CAS7#	M23	$V_{SS}$	T26	S_TRDY#
Н3	CAS5#	M24	S_AD23	U1	SCL
H4	V <sub>CC</sub>	M25	S_C/BE3#	U2	SDA
H23	V <sub>SS</sub>	M26	S_IDSEL	U3	PICCLK
H24	S_REQ0#/S_GNT#	N1	S_INTA#/XINT0#	U4	V <sub>SS</sub>
H25	S_REQ1#	N2	S_INTB#/XINT1#	U23	V <sub>CC</sub>
H26	S_GNT0#/S_REQ#	N3	WAIT#	U24	S_PERR#
J1	MWE1#	N4	$V_{SS}$	U25	S_STOP#
J2	MWE2#	N23	V <sub>CC</sub>	U26	S_LOCK#
J3	MWE0#	N24	S_AD20	V1	HOLD
J4	V <sub>SS</sub>	N25	S_AD22	V2	ICEBUS0



Table 13. 352-Lead HL-PBGA Pinout — Ballpad Number Order (Sheet 3 of 4)

	14410 101 002 2044
Ball #	Signal
V3	HOLDA
V4	V <sub>CC</sub>
V23	V <sub>SS</sub>
V24	S_C/BE1#
V25	S_SERR#
V26	S_PAR
W1	ICEBUS2
W2	ICEBUS3
W3	ICEBUS1
W4	V <sub>SS</sub>
W23	V <sub>CC</sub>
W24	S_AD13
W25	S_AD15
W26	S_AD14
Y1	ICEBUS5
Y2	ICEBUS6
Y3	ICEBUS4
Y4	V <sub>CC</sub>
Y23	$V_{SS}$
Y24	S_AD10
Y25	S_AD12
Y26	S_AD11
AA1	ICEBRK#
AA2	ICEMSG#
AA3	ICEBUS7
AA4	$V_{SS}$
AA23	V <sub>cc</sub>
AA24	S_C/BE0#
AA25	S_AD9
AA26	S_AD8
AB1	ICEVLD#
AB2	ICECLK
AB3	ICELOCK#

Ball # AB4	Signal V <sub>CC</sub>
AB4	Vaa
	• 66
AB23	$V_{SS}$
AB24	S_AD5
AB25	S_AD7
AB26	S_AD6
AC1	ICEADS#
AC2	ICESEL#
AC3	MSGFRM#
AC4	V <sub>SS</sub>
AC5	V <sub>SS</sub>
AC6	V <sub>CC</sub>
AC7	V <sub>SS</sub>
AC8	V <sub>CC</sub>
AC9	V <sub>SS</sub>
AC10	V <sub>CC</sub>
AC11	$V_{SS}$
AC12	V <sub>CC</sub>
AC13	V <sub>SS</sub>
AC14	V <sub>CC</sub>
AC15	V <sub>SS</sub>
AC16	V <sub>CC</sub>
AC17	V <sub>SS</sub>
AC18	V <sub>CC</sub>
AC19	V <sub>SS</sub>
AC20	V <sub>CC</sub>
AC21	$V_{SS}$
AC22	V <sub>CC</sub>
AC23	$V_{SS}$
AC24	S_AD2
AC25	S_AD4
AC26	S_AD3
AD1	V <sub>CC</sub>
AD2	DREQ#

oraci (Oi	1001 0 01 4)
Ball #	Signal
AD3	DACK#
AD4	LOCK#/ONCE#
AD5	FAIL#
AD6	LRST#
AD7	P_INTC#
AD8	V <sub>CC</sub> /V <sub>SS</sub> (1)
AD9	P_AD31
AD10	P_AD28
AD11	P_AD25
AD12	P_IDSEL
AD13	P_AD21
AD14	P_AD18
AD15	P_C/BE2#
AD16	P_TRDY#
AD17	P_LOCK#
AD18	P_PAR
AD19	P_AD14
AD20	P_AD11
AD21	P_AD8
AD22	P_AD6
AD23	P_AD3
AD24	P_AD0
AD25	S_AD1
AD26	V <sub>CC</sub>
AE1	V <sub>CC</sub>
AE2	V <sub>CC</sub>
AE3	STEST
AE4	NC
AE5	WIDTH/HLTD1/RETRY
AE6	P_INTB#
AE7	P_RST#
AE8	P_REQ#
AE9	P_AD29

<sup>1.</sup> Ball AD8 must be tied to either  $V_{CC}$  or  $V_{SS}$ .



Table 13. 352-Lead HL-PBGA Pinout — Ballpad Number Order (Sheet 4 of 4)

Ball #	Signal
AE10	P_AD26
AE11	P_C/BE3#
AE12	P_AD22
AE13	P_AD19
AE14	P_AD16
AE15	P_IRDY#
AE16	P_STOP#
AE17	P_SERR#
AE18	P_AD15
AE19	P_AD12
AE20	P_AD9
AE21	P_AD7
AE22	P_AD4
AE23	P_AD1
AE24	S_AD0

Ball #	Signal
AE25	V <sub>CC</sub>
AE26	V <sub>CC</sub>
AF1	V <sub>CC</sub>
AF2	V <sub>CC</sub>
AF3	V <sub>CC</sub>
AF4	D/C#/RST_MODE#
AF5	WIDTH/HLTD0
AF6	P_INTA#
AF7	P_INTD#
AF8	P_GNT#
AF9	P_AD30
AF10	P_AD27
AF11	P_AD24
AF12	P_AD23
AF13	P_AD20

Ball #	Signal
AF14	P_AD17
AF15	P_FRAME#
AF16	P_DEVSEL#
AF17	P_PERR#
AF18	P_C/BE1#
AF19	P_AD13
AF20	P_AD10
AF21	P_C/BE0#
AF22	P_AD5
AF23	P_AD2
AF24	$V_{CC}$
AF25	V <sub>CC</sub>
AF26	V <sub>CC</sub>



### 3.2 Package Thermal Specifications

The device is specified for operation when  $T_C$  (case temperature) is within the range of  $0^{\circ}$  C to  $115^{\circ}$  C. Case temperature may be measured in any environment to determine whether the processor is within specified operating range. Measure the case temperature at the center of the top surface, opposite the ballpad.

### 3.2.1 Thermal Specifications

This section defines the terms used for thermal analysis.

#### 3.2.1.1 Ambient Temperature

Ambient temperature,  $T_A$ , is the temperature of the ambient air surrounding the package. In a system environment, ambient temperature is the temperature of the air upstream from the package.

### 3.2.1.2 Case Temperature

To ensure functionality and reliability, the device is specified for proper operation when the case temperature,  $T_C$ , is within the specified range in Table 16.

When measuring case temperature, attention to detail is required to ensure accuracy. If a thermocouple is used, calibrate it before taking measurements. Errors may result when the measured surface temperature is affected by the surrounding ambient air temperature. Such errors may be due to a poor thermal contact between thermocouple junction and the surface, heat loss by radiation, or conduction through thermocouple leads.

To minimize measurement errors:

- Use a 35 gauge K-type thermocouple or equivalent.
- Attach the thermocouple bead or junction to the package top surface at a location corresponding to the center of the die (Figure 5). The center of the die gives a more accurate measurement and less variation as the boundary condition changes.

Attach the thermocouple bead or junction at a 90° angle by an adhesive bond (such as thermal epoxy or heat-tolerant tape) to the package top surface as shown in Figure 5. When a heat sink is attached, drill a hole through the heat sink to allow contact with the package above the center of the die. The hole diameter should be no larger than 3.8 mm as shown in Figure 6.

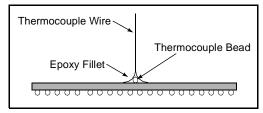


Figure 5. Thermocouple Attachment No Heat Sink

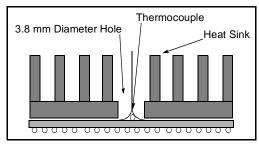


Figure 6. Thermocouple Attachment - With Heat Sink

#### 3.2.1.3 Thermal Resistance

The thermal resistance value for the case-to-ambient,  $\theta_{CA}$ , is used as a measure of the cooling solution's thermal performance.



#### 3.2.2 Thermal Analysis

This thermal analysis is based on the following assumptions:

- Power dissipation is a constant 8 W.
- Maximum case temperature is 115° C.

Table 14 lists the case-to-ambient thermal resistances of the 80960RP for different air flow rates with and without a heat sink.

To calculate  $T_A$ , the maximum ambient temperature to conform to a particular case temperature:

$$T_A = T_C - P(\theta_{CA})$$

Compute P by multiplying I<sub>CC</sub> (from Table 18) and V<sub>CC</sub>. The device is specified for operation at V<sub>cc</sub> = 5.0 V ±5% at 33.33 MHz. Values for  $\theta_{JC}$  and  $\theta_{CA}$  are given in Table 14.

Junction temperature  $(T_J)$  is commonly used in reliability calculations.  $T_J$  can be calculated from  $\theta_{JC}$  (thermal resistance from junction to case) using the following equation:

$$T_J = T_C + P(\theta_{JC})$$

Similarly, when  $T_A$  is known, the corresponding case temperature  $(T_C)$  can be calculated as follows:

$$T_C = T_A + P(\theta_{CA})$$

The  $\theta_{JA}$  (Junction to Ambient) for this package is currently estimated at 9.35° C/Watt with no airflow.

$$\theta_{JA} = \theta_{JC} + \theta_{CA}$$

Thermal Resistance — °C/Watt								
Airflow — ft./min (m/sec)								
Parameter	0 (0)	50 (0.25)	100 (0.50)	200 (1.01)	300 (1.52)	400 (2.03)	600 (3.04)	800 (4.06)
$\theta_{JC}$ (Junction-to-Case)	0.60	0.60	0.60	0.60	0.60	0.60	0.60	0.60
θ <sub>CA</sub> (Case-to-Ambient) Without Heatsink	8.75	7.42	6.58	6.11	5.79	5.61	5.49	5.47
θ <sub>CA</sub> (Case-to-Ambient) With Heatsink <sup>2</sup>	7.31	6.00	5.21	4.80	4.52	4.37	4.26	4.23
Φ <sub>JC</sub> Φ <sub>CA</sub>						<u> </u>		

- 1. This table applies to a HL-PBGA device soldered directly onto a board.
- 2. See Table 15 for heatsink information.



### 3.3 Sources for Heatsinks and Accessories

The following is a list of suggested sources for heatsinks and accessories. This is neither an endorsement nor a warranty of the performance of any of the listed products and/or companies.

Table 15. Heatsink Information

Manufacturer	Part No.	Heatsink Dimensions (mm)	Product Description
Thermalloy, Inc. 2021 West Valley View Lane Dallas, TX 75234-8993 Tel: (214) 243-4321 FAX: (214) 241-4656	Heatsink: 2338B BGA Clip: 20812-2	32 X 34 X 12.6	Thermalloy Heatsink; use with BGA Clip and Parker Chromerics Thermflow tape
Parker Chromerics 77 Dragon Court Woburn, MA 01888 Tel: (617) 935-4850 FAX: (617) 933-4318	T705	NA	Thermflow tape; use with Thermalloy BGA Clip
AAVID Thermal Technologies, Inc. One Kool Path P.O. Box 400 Laconia, N.H. 13247-0400 Tel: (603) 528-3400 FAX: (603) 527-2129	Heatsink: 364424B00032	40.5 X 40 X 11	AAVID Heatsink; use with pre-applied thermal adhesive tape (Ther-A-Grip)



### 4.0 ELECTRICAL SPECIFICATIONS

# 4.1 Absolute Maximum Ratings

Parameter	Maximum Rating
Storage Temperature	–55° C to + 125° C
Case Temperature Under Bias	0° C to + 115° C
Supply Voltage wrt. V <sub>SS</sub>	-0.5 V to + 6.5 V
Voltage on Any Ball wrt. V <sub>SS</sub>	-0.5 V to V <sub>CC</sub> + 0.5 V

NOTICE: This data sheet contains information on products in the sampling and initial production phases of development. The specifications are subject to change without notice. Contact your local Intel representative before finalizing a design.

†WARNING: Stressing the device beyond the "Absolute Maximum Ratings" may cause permanent damage. These are stress ratings only. Operation beyond the "Operating Conditions" is not recommended and extended exposure beyond the "Operating Conditions" may affect device reliability.

**Table 16. Operating Conditions** 

Symbol	Parameter	Min	Max	Units	Notes
$V_{CC}$	Supply Voltage	4.75	5.25	V	
F <sub>S_CLK</sub>	Input Clock Frequency	16	33.33	MHz	
T <sub>C</sub>	Case Temperature Under Bias GC80960RP (352 HL-PBGA)	0	115	°C	



# 4.2 Targeted DC Specifications

Table 17. DC Characteristics

Symbol	Parameter	Min	Max	Units	Notes
V <sub>IL</sub>	Input Low Voltage	-0.5	8.0	V	(1)
V <sub>IH</sub>	Input High Voltage	2.0	V <sub>CC</sub> + 0.5	V	(1)
V <sub>OL1</sub>	Output Low Voltage Processor signals		0.45	V	I <sub>OL</sub> = 6 mA (3)
V <sub>OH1</sub>	Output High Voltage Processor signals	2.4 V <sub>CC</sub> - 0.5		V	$I_{OH} = -2 \text{ mA (3)}$ $I_{OH} = -200 \mu\text{A (3)}$
V <sub>OL2</sub>	Output Low Voltage PCI signals		0.55	V	I <sub>OL</sub> = 6 mA (1)
V <sub>OH2</sub>	Output High Voltage PCI signals	2.4		V	I <sub>OH</sub> = -2 mA (1)
V <sub>OL3</sub>	Output Low Voltage Memory Controller Normal drive		0.45	V	I <sub>OL</sub> = 6 mA (4)
V <sub>OH3</sub>	Output High Voltage Memory Controller Normal drive	2.4		V	I <sub>OH</sub> = -2 mA (4)
V <sub>OL4</sub>	Output Low Voltage Memory Controller High Drive		0.45	V	I <sub>OL</sub> = 7 mA
V <sub>OH4</sub>	Output High Voltage Memory Controller High Drive	2.4		V	I <sub>OH</sub> = -2 mA
V <sub>OL5</sub>	Output Low Voltage APIC Data Lines		0.45	V	I <sub>OL</sub> = 20 mA
C <sub>IN</sub>	Input Capacitance - HL-PBGA		10	pF	$F_{S\_CLK} = T_F Min (1, 2)$
C <sub>OUT</sub>	I/O or Output Capacitance - HL-PBGA		10	pF	$F_{S\_CLK} = T_F Min (1, 2)$
C <sub>CLK</sub>	S_CLK Capacitance - HL-PBGA	5	12	pF	$F_{S\_CLK} = T_F Min (1, 2)$
C <sub>IDSEL</sub>	IDSEL Ball Capacitance		8	pF	(1)
L <sub>PIN</sub>	Ball Inductance		20	nΗ	(1)

- 1. As required by the PCI Local Bus Specification Revision 2.1.
- 2. Not tested.
- 3. Processor signals include AD31:0, ALE, ADS#, BE3:0#, WIDTH/HLTD0, WIDTH/HLTD1/RETRY, D/C#/RST\_MODE#, W/R#, DT/R#, DEN#, BLAST#, LRDYRCV#, LOCK#/ONCE#, HOLD, FAIL#, TDO, DACK#, WAIT#, SDA, SCL.
- Memory Controller signals include MA11:0, DP3:0, RAS3:0#, CAS7:0#, MWE3:0#, DWE1:0#, DALE1:0, CE1:0#, LEAF1:0#.
- 5. Memory Controller signals capable of high drive are MA11:0, CAS7:0#, RAS3:0#, DWE1:0#.



Table 18. I<sub>CC</sub> Characteristics

Symbol	Parameter	Тур	Max	Units	Notes
I <sub>L11</sub>	Input Leakage Current for each signal except LOCK#/ONCE#, WIDTH/HLTD0, WIDTH/HLTD1/RETRY, BLAST#, D/C#/RST_MODE#, DEN#,TMS, TRST#, TDI		± 5	μΑ	$0 \le V_{IN} \le V_{CC}$
I <sub>L12</sub>	Input Leakage Current for LOCK#/ONCE#, WIDTH/HLTD0, WIDTH/HLTD1/RETRY, BLAST#, D/C#/RST_MODE#, DEN#, TMS, TRST#, TDI	-140	-250	μΑ	V <sub>IN</sub> = 0.45 V (1)
I <sub>LO</sub>	Output Leakage Current		± 5	μΑ	$0.4 \le V_{OUT} \le V_{CC}$
I <sub>CC</sub> Active (Power Supply)	Power Supply Current		1.52	Α	(1,2)
I <sub>CC</sub> Active (Thermal)	Thermal Current	1.28		Α	(1,3)
I <sub>CC</sub> Active (Power Modes)	Reset Mode ONCE Mode		1.09 0.25	Α	(4) (4)

- 1. Measured with device operating and outputs loaded to the test condition in Figure 7.
- I<sub>CC</sub> Active (Power Supply) value is provided for selecting your system's power supply. It is measured using one of the
  worst case instruction mixes with V<sub>CC</sub> = 5.25 V and ambient temperature = 45 ° C. This parameter is characterized but
  not tested.
- I<sub>CC</sub> Active (Thermal) value is provided for your system's thermal management. Typical I<sub>CC</sub> is measured with V<sub>CC</sub> = 5.0 V and ambient temperature = 45 ° C. This parameter is characterized but not tested.
- 4.  $I_{CC}$  Test (Power modes) refers to the  $I_{CC}$  values that are tested when the device is in Reset mode or ONCE mode with  $V_{CC}$  = 5.25 V and ambient temperature = 45 ° C.



# 4.3 Targeted AC Specifications

Table 19. Input Clock Timings

Symbol	Parameter	Min	Max	Units	Notes
T <sub>F</sub>	S_CLK Frequency	16	33.33	MHz	
T <sub>C</sub>	S_CLK Period	30	62.5	ns	(1)
T <sub>CS</sub>	S_CLK Period Stability		±250	ps	Adjacent Clocks (2,3)
T <sub>CH</sub>	S_CLK High Time	12		ns	Measured at 1.5 V (2,3)
T <sub>CL</sub>	S_CLK Low Time	12		ns	Measured at 1.5 V (2,3)
T <sub>CR</sub>	S_CLK Rise Time		4	V/ns	0.4 V to 2.4 V (2,3)
T <sub>CF</sub>	S_CLK Fall Time		4	V/ns	2.4 V to 0.4 V (2,3)

#### NOTES:

- 1. See Figure 8.
- 2. To ensure a 1:1 relationship between the amplitude of the input jitter and the internal clock, the jitter frequency spectrum should not have any power peaking between 500 KHz and 1/3 of the S\_CLK frequency.
- 3. Not tested.

Table 20. Synchronous Output Timings

Symbol	Parameter	Min	Max	Units	Notes
T <sub>OV1</sub>	Output Valid Delay - All Signals Except ALE Inactive and DT/R#	3	15.5	ns	(1,2)
T <sub>OV2</sub>	Output Valid Delay, DT/R#	0.5 T <sub>C</sub> +3	0.5 T <sub>C</sub> +15	ns	(2)
T <sub>OV3</sub>	Output Valid Delay - PCI Signals Except P_REQ#, S_GNT0#/S_REQ#, and S_GNT5:1#	2	12	ns	(2)
T <sub>OV4</sub>	Output Valid Delay P_REQ#, S_GNT0#/S_REQ#, and S_GNT5:1#	2	12	ns	(2)
T <sub>OV5</sub>	Output Valid Delay - DP3:0	3	19	ns	(2)
T <sub>OF</sub>	Output Float Delay	3	13	ns	(3,4)

- 1. Inactive ALE refers to the falling edge of ALE. For inactive ALE timings, see Table 22, Relative Output Timings (pg. 39).
- See Figure 9, T<sub>OV</sub> Output Delay Waveform (pg. 45).
- A float condition occurs when the output current becomes less than I<sub>LO</sub>. Float delay is not tested, but is designed to be no longer than the valid delay.
- 4. See Figure 10, TOF Output Float Waveform (pg. 45).



Table 21. Synchronous Input Timings

Sym	Parameter	Min	Max	Units	Notes
T <sub>IS1</sub>	Input Setup to S_CLK — AD31:0, NMI#, XINT7:4#, S_INT[A:D]#/XINT3:0#, DP3:0#	7		ns	(1,2,4)
T <sub>IH1</sub>	Input Hold from S_CLK — AD31:0, NMI#, XINT7:4#, S_INT[A:D]#/XINT3:0#, DP3:0#	2		ns	(1,2)
T <sub>IS2</sub>	Input Setup to S_CLK — RDYRCV# and HOLD	10		ns	(2)
T <sub>IH2</sub>	Input Hold from S_CLK — RDYRCV# and HOLD	2		ns	(2)
T <sub>IS3</sub>	Input Setup to S_CLK — LOCK#/ONCE#, STEST	7		ns	(1,2)
T <sub>IH3</sub>	Input Hold from S_CLK — LOCK#/ONCE#, STEST	3		ns	(1,2)
T <sub>IS4</sub>	Input Setup to S_CLK — DREQ#	12		ns	(2)
T <sub>IH4</sub>	Input Hold from S_CLK — DREQ#	7		ns	(2)
T <sub>IS5</sub>	Input Setup to S_CLK — PCI Signals Except P_GNT#, S_REQ0#/S_GNT#, and S_REQ5:1#	8		ns	(2,4)
T <sub>IH5</sub>	Input Hold from S_CLK — PCI Signals	0		ns	(2,4)
T <sub>IS6</sub>	Input Setup to S_CLK — P_RST#	6		ns	(2,3)
T <sub>IH6</sub>	Input Hold to S_CLK — P_RST#	2		ns	(2,3)
T <sub>IS7</sub>	Input Setup to S_CLK — P_GNT#	10		ns	(2)
T <sub>IS8</sub>	Input Setup to S_CLK — S_REQ0#/S_GNT# and S_REQ5:1#	12		ns	(2)
T <sub>IS9</sub>	Input Setup to P_RST# — WIDTH/HLTD0, WIDTH/HLTD1/RETRY, D/C#/RST_MODE#	7		ns	(1,2,4)
T <sub>IH9</sub>	Input Hold from P_RST# — WIDTH/HLTD0, WIDTH/HLTD1/RETRY, D/C#/RST_MODE#	3		ns	(1,2,4)

- Setup and hold times must be met for proper processor operation. NMI#, XINT7:4#, and S\_INT[A:D]#/XINT3:0# may be synchronous or asynchronous. Meeting setup and hold time guarantees recognition at a particular clock edge.
   For asynchronous operation, NMI#, XINT7:4#, and S\_INT[A:D]#/XINT3:0# must be asserted for a minimum of two S\_CLK periods to guarantee recognition.
- 2. See Figure 11, T<sub>IS</sub> and T<sub>IH</sub> Input Setup and Hold Waveform (pg. 46).
- 3. P\_RST# may be synchronous or asynchronous. Meeting setup and hold time guarantees recognition at a particular clock edge.
- 4. Guaranteed by design. May not be 100% tested.



### 4.3.1 Relative Output Timings

**Table 22. Relative Output Timings** 

Symbol	Parameter	Min	Max	Units	Notes
$T_{LXL}$	ALE Width	0.5T <sub>C</sub> -3		ns	(1, 2)
T <sub>LXA</sub>	Address Hold from ALE Inactive	0.5T <sub>C</sub> -3		ns	Equal Loading (1, 2)
$T_{DXD}$	DT/R# Valid to DEN# Active	0.5T <sub>C</sub> -3		ns	Equal Loading (1, 3)

#### NOTES:

- 1. Guaranteed by design. May not be 100% tested.
- 2. See Figure 12.
- 3. See Figure 13.

#### 4.3.2 Memory Controller Relative Output Timings

Table 23. Fast Page Mode Non-interleaved DRAM Output Timings

Symbol	Description	Min	Max	Units	Notes
T <sub>OV6</sub>	RAS3:0# Rising and Falling edge Output Valid Delay	2	10	ns	
T <sub>OV7</sub>	CAS7:0# Rising Edge Output Valid Delay	2	10	ns	
T <sub>OV8</sub>	CAS7:0# Falling Edge Output Valid Delay	0.5Tc+2	0.5Tc+10	ns	1
T <sub>OV9</sub>	MA11:0 Output Valid Delay-Row Address	0.5Tc+2	0.5Tc+11	ns	1
T <sub>OV10</sub>	MA11:0 Output Valid Delay-Column Address	2	12.5	ns	
T <sub>OV11</sub>	DWE1:0# Rising and Falling edge Output Valid Delay	2	11	ns	

#### NOTES:

 Signal generated on the rising edge of an internally generated 2XCLK which corresponds to the center of an S\_CLK period. For testing purposes, the signal is specified relative to the rising edge of S\_CLK with the 0.5Tc period offset.

Table 24. Fast Page Mode Interleaved DRAM Output Timings (Sheet 1 of 2)

Symbol	Description	Min	Max	Units	Notes
T <sub>OV12</sub>	RAS3:0# Rising and Falling edge Output Valid Delay	2	10	ns	
T <sub>OV13</sub>	CAS7:0# Rising Edge Output Valid Delay	2	10	ns	
T <sub>OV14</sub>	CAS7:0# Falling Edge Output Valid Delay	0.5Tc+2	0.5Tc+10	ns	1
T <sub>OV15</sub>	MA11:0 Output Valid Delay-Row Address	0.5Tc+2	0.5Tc+11	ns	1
T <sub>OV16</sub>	MA11:0 Output Valid Delay-Column Address	2	12.5	ns	

#### NOTE:

 Signal generated on the rising edge of an internally generated 2XCLK which corresponds to the center of an S\_CLK period. For testing purposes, the signal is specified relative to the rising edge of S\_CLK with the 0.5Tc period offset.



Table 24. Fast Page Mode Interleaved DRAM Output Timings (Sheet 2 of 2)

Symbol	Description	Min	Max	Units	Notes
T <sub>OV17</sub>	DWE1:0# Rising and Falling Edge Output Valid Delay		11	ns	
T <sub>OV18</sub>	DALE1:0 Initial Falling Edge Output Valid Delay	2	11	ns	
T <sub>OV19</sub>	DALE1:0 Burst Falling Edge Output Valid Delay	0.5Tc+2	0.5Tc+11	ns	1
T <sub>OV20</sub>	DALE1:0 Rising Edge Output Valid Delay	2	11	ns	
T <sub>OV21</sub>	LEAF1:0# Rising and Falling Edge Output Valid Delay	2	11	ns	

#### NOTE:

 Signal generated on the rising edge of an internally generated 2XCLK which corresponds to the center of an S\_CLK period. For testing purposes, the signal is specified relative to the rising edge of S\_CLK with the 0.5Tc period offset.

**Table 25. EDO DRAM Output Timings** 

Symbol	Description	Min	Max	Units	Notes
T <sub>OV22</sub>	RAS3:0# Rising and Falling Edge Output Valid Delay	2	10	ns	
T <sub>OV23</sub>	CAS7:0# Rising Edge Output Valid Delay - Read Cycles	0.5Tc+2	0.5Tc+10	ns	1
T <sub>OV24</sub>	CAS7:0# Falling Edge Output Valid Delay - Read Cycles	2	10	ns	
T <sub>OV25</sub>	CAS7:0# Rising Edge Output Valid Delay - Write Cycles	2	10	ns	
T <sub>OV26</sub>	CAS7:0# Falling Edge Output Valid Delay - Write Cycles	0.5Tc+2	0.5Tc+10	ns	1
T <sub>OV27</sub>	MA11:0 Output Valid Delay - Row Address	0.5Tc+2	0.5Tc+11	ns	1
T <sub>OV28</sub>	MA11:0 Output Valid Delay - Column Address Read Cycles	0.5Tc+2	0.5Tc+12.5	ns	1
T <sub>OV29</sub>	MA11:0 Output Valid Delay - Column Address Write Cycles	2	12.5	ns	
T <sub>OV30</sub>	DWE1:0# Rising and Falling Edge Output Valid Delay	2	11	ns	

#### NOTES:

 Signal generated on the rising edge of an internally generated 2XCLK which corresponds to the center of an S\_CLK period. For testing purposes, the signal is specified relative to the rising edge of S\_CLK with the 0.5Tc period offset.



Table 26. BEDO DRAM Output Timings

Symbol	Description		Max	Units	Notes
T <sub>OV31</sub>	RAS3:0# Rising and Falling Edge Output Valid Delay	2	11	ns	
T <sub>OV32</sub>	CAS7:0# Rising Edge Output Valid Delay - Read Cycles	0.5Tc+2	0.5Tc+11	ns	1
T <sub>OV33</sub>	CAS7:0# Falling Edge Output Valid Delay - Read Cycles	2	11	ns	
T <sub>OV34</sub>	CAS7:0# Rising Edge Output Valid Delay - Write Cycles	2	11	ns	
T <sub>OV35</sub>	CAS7:0# Falling Edge Output Valid Delay - Write Cycles	0.5Tc+2	0.5Tc+11	ns	1
T <sub>OV36</sub>	MA11:0 Output Valid Delay - Row Address	0.5Tc +2	0.5Tc+11	ns	1
T <sub>OV37</sub>	MA11:0 Output Valid Delay - Column Address Read Cycles	0.5Tc +2	0.5Tc+14	ns	1
T <sub>OV38</sub>	MA11:0 Output Valid Delay - Column Address Write Cycles	2	14	ns	
T <sub>OV39</sub>	DWE1:0# Rising and Falling Edge Output Valid Delay	2	11	ns	

#### NOTES:

Table 27. SRAM/ROM Output Timings

Symbol	Description	Min	Max	Units	Notes
T <sub>OV40</sub>	CE1:0# Rising and Falling Edge Output Valid Delay		11	ns	
T <sub>OV41</sub>	MWE3:0# Rising Edge Output Valid Delay	2	11	ns	
T <sub>OV42</sub>	MWE3:0# Falling Edge Output Valid Delay	0.5Tc +1	0.5Tc +11	ns	1
T <sub>OV43</sub>	MA11:0 Output Valid Delay - Initial Address	0.5Tc +2	0.5Tc +14	ns	
T <sub>OV44</sub>	MA11:0 Output Valid Delay - Burst Address	2	14	ns	

#### NOTES:

 Signal generated on the rising edge of an internally generated 2XCLK which corresponds to the center of an S\_CLK period. For testing purposes, the signal is specified relative to the rising edge of S\_CLK with the 0.5Tc period offset.

Signal generated on the rising edge of an internally generated 2XCLK which corresponds to the center of an S\_CLK period. For testing purposes, the signal is specified relative to the rising edge of S\_CLK with the 0.5Tc period offset.



### 4.3.3 Boundary Scan Test Signal Timings

Table 28. Boundary Scan Test Signal Timings

Symbol	Parameter	Min	Max	Units	Notes
T <sub>BSF</sub>	TCK Frequency	0	.5T <sub>F</sub>	MHz	
T <sub>BSCH</sub>	TCK High Time	15		ns	Measured at 1.5 V (1)
T <sub>BSCL</sub>	TCK Low Time	15		ns	Measured at 1.5 V (1)
T <sub>BSCR</sub>	TCK Rise Time		5	ns	0.8 V to 2.0 V (1)
T <sub>BSCF</sub>	TCK Fall Time		5	ns	2.0 V to 0.8 V (1)
T <sub>BSIS1</sub>	Input Setup to TCK — TDI, TMS	4		ns	
T <sub>BSIH1</sub>	Input Hold from TCK — TDI, TMS	6		ns	
T <sub>BSOV1</sub>	TDO Valid Delay	3	30	ns	Relative to falling edge of TCK
T <sub>BSOF1</sub>	TDO Float Delay	3	30	ns	Relative to falling edge of TCK
T <sub>BSOV2</sub>	All Outputs (Non-Test) Valid Delay	3	30	ns	Relative to falling edge of TCK
T <sub>BSOF2</sub>	All Outputs (Non-Test) Float Delay	3	30	ns	Relative to falling edge of TCK
T <sub>BSIS2</sub>	Input Setup to TCK — All Inputs (Non-Test)	4		ns	
T <sub>BSIH2</sub>	Input Hold from TCK — All Inputs (Non-Test)	6		ns	

### NOTES:

# 4.3.4 APIC Bus Interface Signal Timings

Table 29. APIC Bus Interface Signal Timings

Symbol	Parameter	Min	Max	Units	Notes
T <sub>APF</sub>	PICCLK Frequency	2	16.66	MHz	
T <sub>APC</sub>	PICCLK Period	60	500	ns	
T <sub>APCH</sub>	PICCLK High Time	9		ns	
T <sub>APCL</sub>	PICCLK Low Time	9		ns	
T <sub>APCR</sub>	PICCLK Rise Time	1	5	ns	(1)
T <sub>APCF</sub>	PICCLK Fall Time	1	5	ns	(1)
T <sub>APIS1</sub>	Input Setup to PICCLK — PICD1:0	3		ns	
T <sub>APIH1</sub>	Input Hold from PICCLK — PICD1:0	2.5		ns	
T <sub>APOF</sub>	Output Float Delay from PICCLK — PICD1:0	4	16	ns	(1)
T <sub>APOVI</sub>	Output Valid Delay from PICCLK — PICD1:0 (High to Low)	4	22	ns	

#### NOTES:

1. Not tested.

<sup>1.</sup> Not tested.



# 4.3.5 I<sup>2</sup>C Interface Signal Timings

Table 30. I<sup>2</sup>C Interface Signal Timings

Symbol	Parameter	Std.	Mode	Fast Mo	ode	Units	Notes
	Farameter	Min	Max	Min	Max	Onits	
F <sub>SCL</sub>	SCL Clock Frequency	0	100	0	400	KHz	
T <sub>BUF</sub>	Bus Free Time Between STOP and START Condition			1.3		μs	(1)
T <sub>HDSTA</sub>	Hold Time (repeated) START Condition			0.6		μs	(1,3)
$T_{LOW}$	SCL Clock Low Time			1.3		μs	(1,2)
T <sub>HIGH</sub>	SCL Clock High Time			0.6		μs	(1,2)
T <sub>SUSTA</sub>	Setup Time for a Repeated START Condition	4.7		0.6		μs	(1)
T <sub>HDDAT</sub>	Data Hold Time	0		0	0.9	μs	(1)
T <sub>SUDAT</sub>	Data Setup Time	250		100		ns	(1)
T <sub>R</sub>	SCL and SDA Rise Time		1000	20+0.1C <sub>b</sub>	300	ns	(1,4)
T <sub>F</sub>	SCL and SDA Fall Time		300	20+0.1C <sub>b</sub>	300	ns	(1,4)
T <sub>SUSTO</sub>	Setup Time for STOP Condition	4		0.6		μs	(1)

- 1. See Figure 14.
- 2. Not tested.
- 3. After this period, the first clock pulse is generated.
- 4.  $C_b$  = the total capacitance of one bus line, in pF.



# 4.4 AC Test Conditions

The AC Specifications in Section 4.3, Targeted AC Specifications (pg. 37) are tested with the 50 pF load indicated in Figure 7.

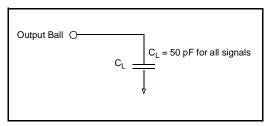


Figure 7. AC Test Load

# 4.5 AC Timing Waveforms

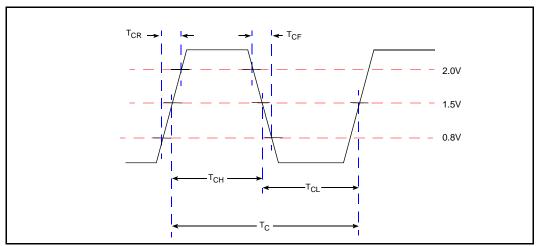


Figure 8. S\_CLK, TCLK Waveform



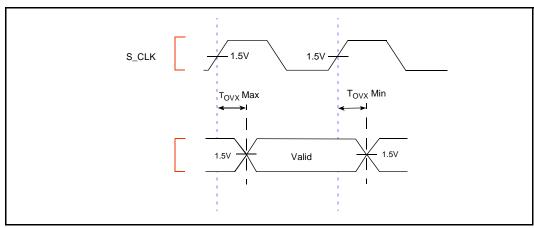


Figure 9. ToV Output Delay Waveform

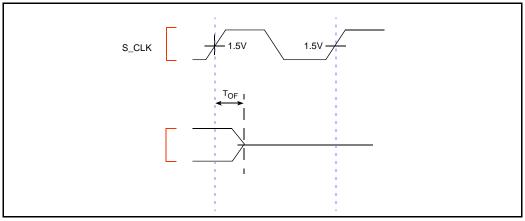


Figure 10. T<sub>OF</sub> Output Float Waveform



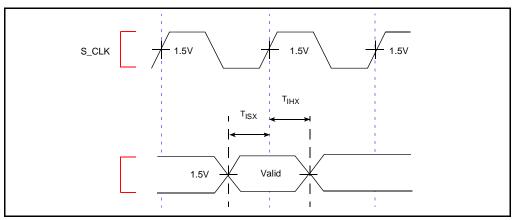


Figure 11.  $T_{\text{IS}}$  and  $T_{\text{IH}}$  Input Setup and Hold Waveform

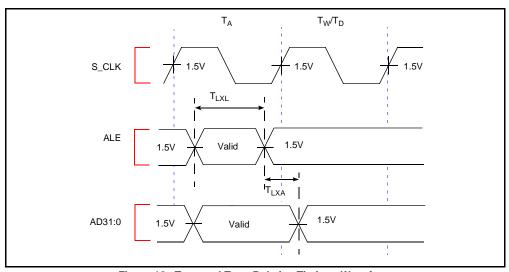


Figure 12.  $T_{LXL}$  and  $T_{LXA}$  Relative Timings Waveform



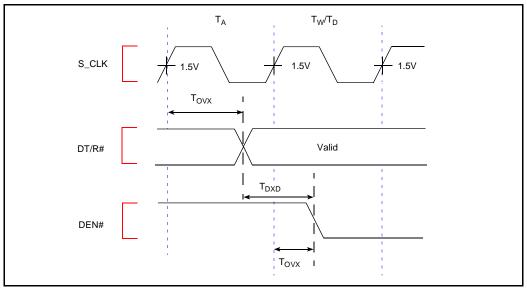


Figure 13. DT/R# and DEN# Timings Waveform

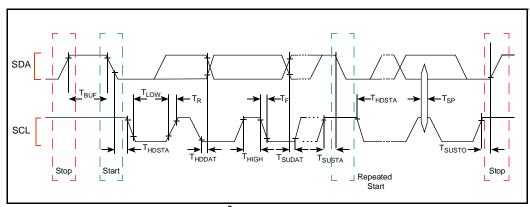


Figure 14. I<sup>2</sup>C Interface Signal Timings



# 4.6 Memory Controller Output Timing Waveforms

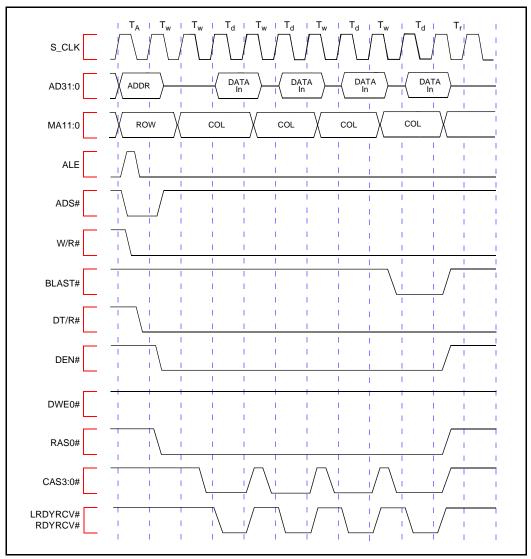


Figure 15. Fast Page-Mode Read Access, Non-Interleaved, 2,1,1,1 Wait State, 32-Bit 80960 Local Bus



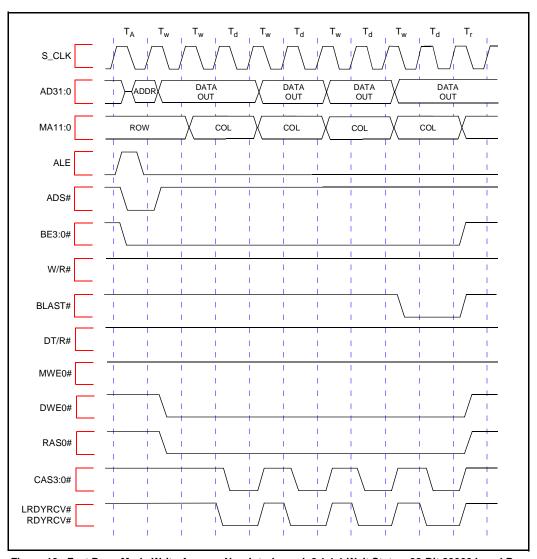


Figure 16. Fast Page-Mode Write Access, Non-Interleaved, 2,1,1,1 Wait States, 32-Bit 80960 Local Bus



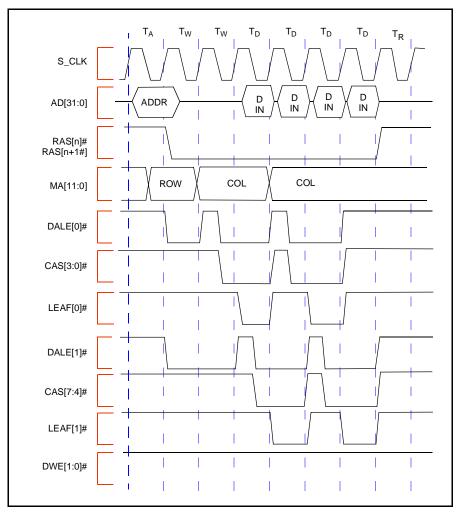


Figure 17. FPM DRAM System Read Access, Interleaved, 2,0,0,0 Wait States



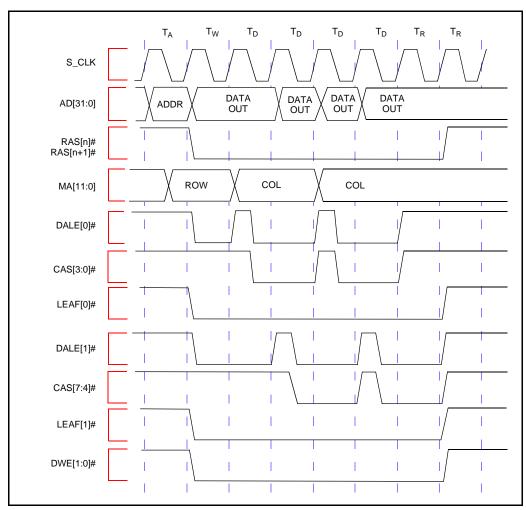


Figure 18. FPM DRAM System Write Access, Interleaved, 1,0,0,0 Wait States



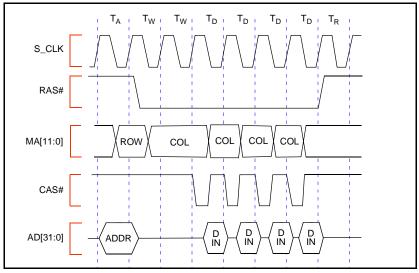


Figure 19. EDO DRAM, Read Cycle

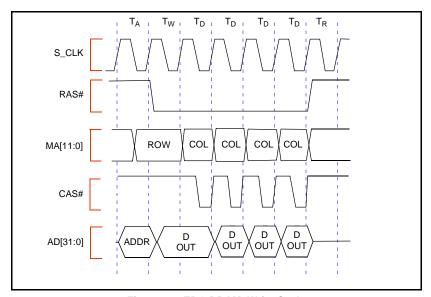


Figure 20. EDO DRAM, Write Cycle



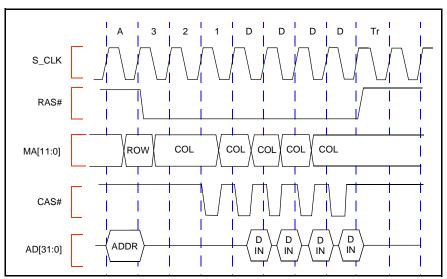


Figure 21. BEDO DRAM, Read Cycle

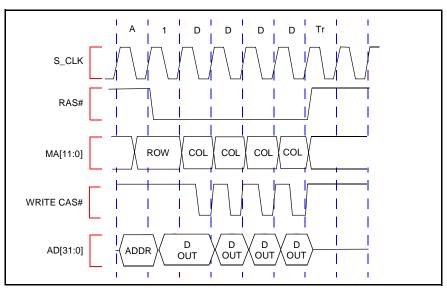


Figure 22. BEDO DRAM, Write Cycle



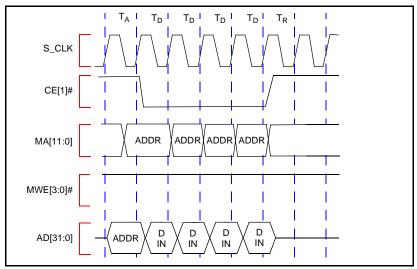


Figure 23. 32-Bit Bus, SRAM Read Accesses with 0 Wait States

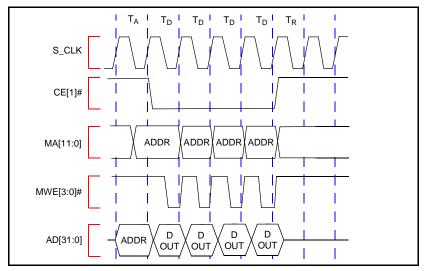


Figure 24. 32-Bit Bus, SRAM Write Accesses with 0 Wait States



### 5.0 BUS FUNCTIONAL WAVEFORMS

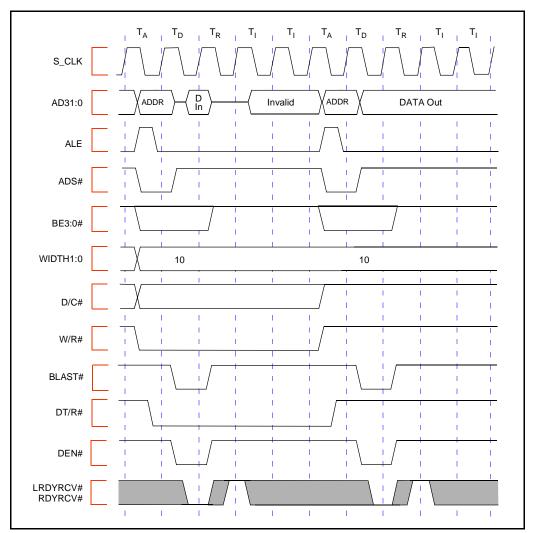


Figure 25. Non-Burst Read and Write Transactions without Wait States, 32-Bit 80960 Local Bus



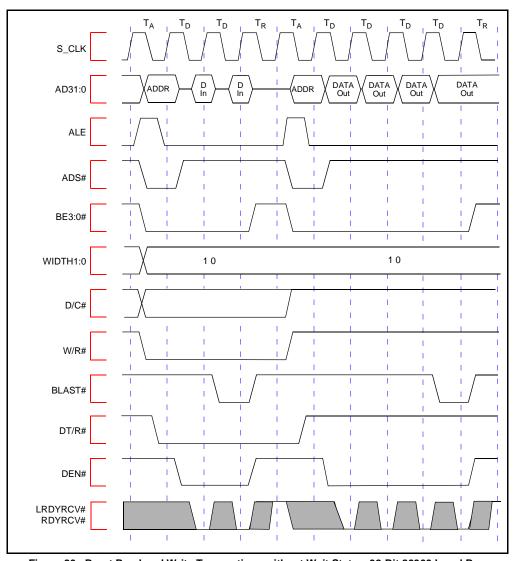


Figure 26. Burst Read and Write Transactions without Wait States, 32-Bit 80960 Local Bus



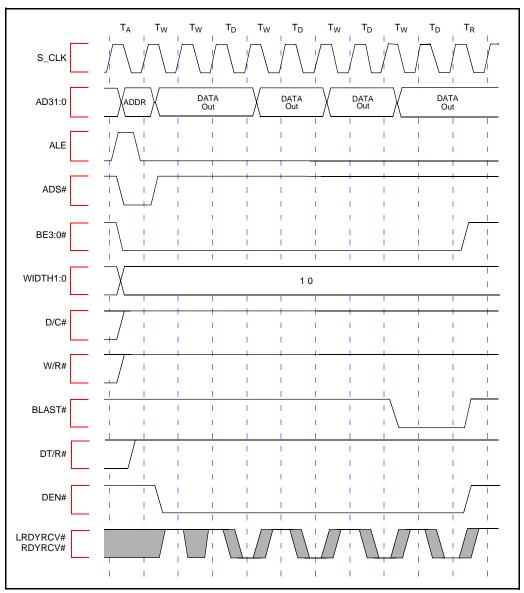


Figure 27. Burst Write Transactions with 2,1,1,1 Wait States, 32-Bit 80960 Local Bus



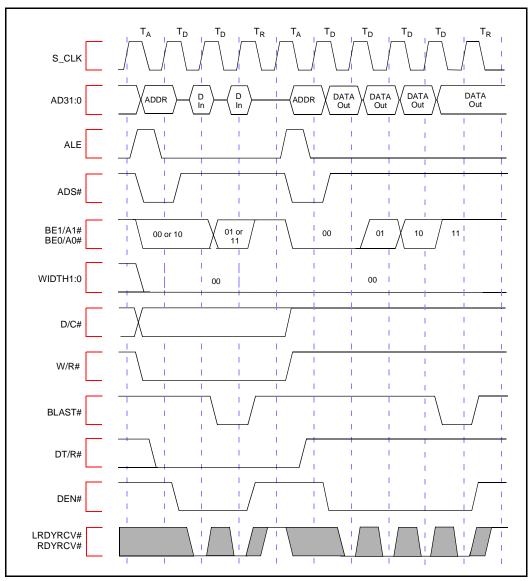


Figure 28. Burst Read and Write Transactions without Wait States, 8-Bit 80960 Local Bus



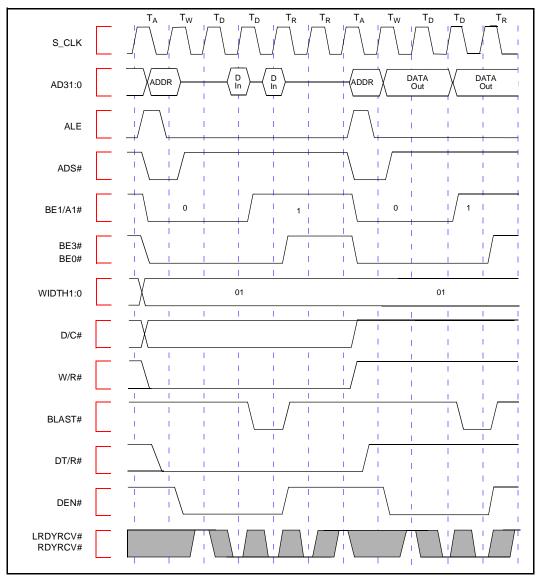


Figure 29. Burst Read and Write Transactions with 1, 0 Wait States and Extra Tr State on Read, 16-Bit 80960 Local Bus



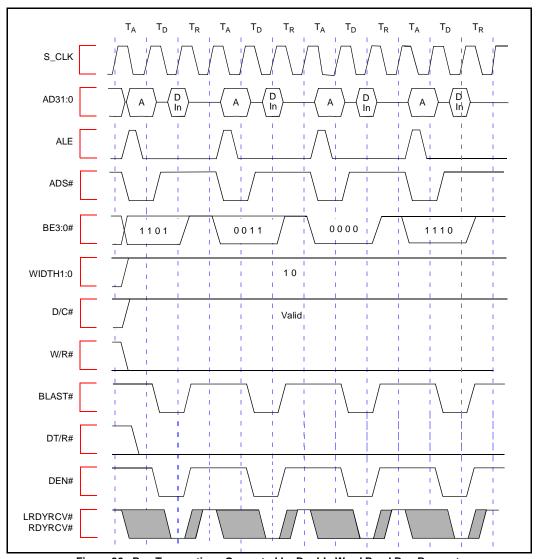


Figure 30. Bus Transactions Generated by Double Word Read Bus Request, Misaligned One Byte From Quad Word Boundary, 32-Bit 80960 Local Bus, Little Endian



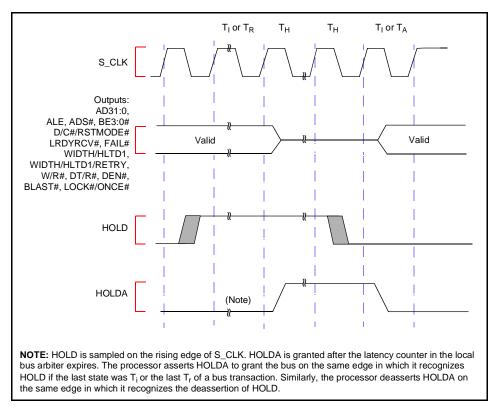


Figure 31. HOLD/HOLDA Waveform For Bus Arbitration



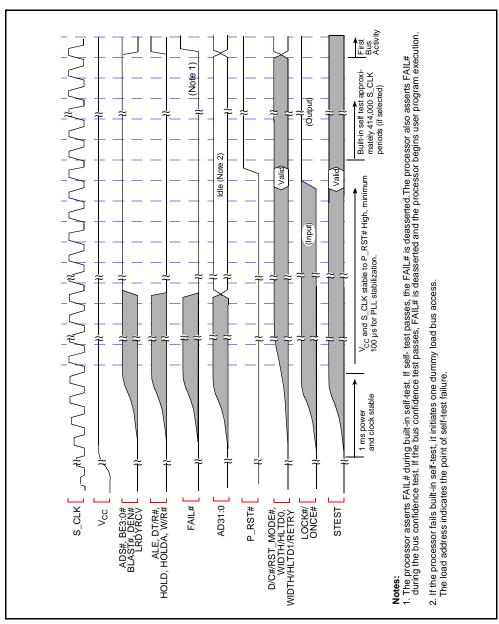


Figure 32. 80960 Core Cold Reset Waveform



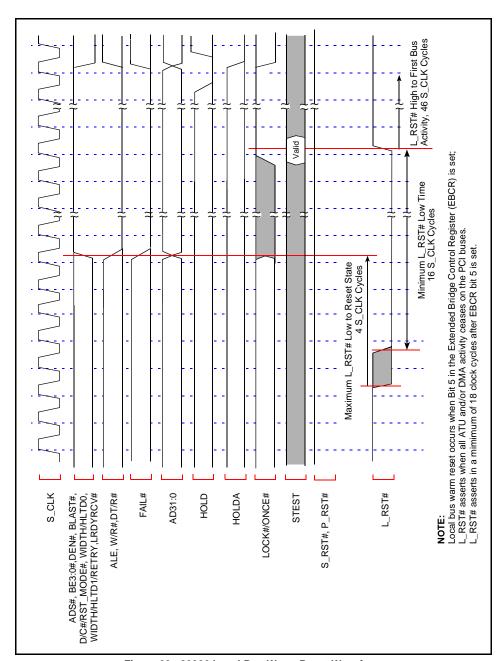


Figure 33. 80960 Local Bus Warm Reset Waveform



#### 6.0 DEVICE IDENTIFICATION ON RESET

The DEVICEID register contains a numeric value which identifies the processor type and stepping. During initialization, the value is also placed in g0. The value is compliant with the IEEE 1149.1 specification and Intel standards. Figure 34 shows the register's fields; Table 31 defines the fields and values. Table 32 identifies the device stepping register values, in hexadecimal and binary, contained in the DEVICEID register, the Address Translation Unit ID register (ATUID) and the Revision ID register (RIDR).

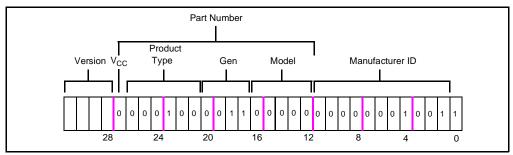


Figure 34. 80960RP Device ID Register (DEVICEID)

Table 31. 80960RP Device ID Register Field Definitions

Field	Value	Definition
Version	0000 = A-0 Step	Indicates stepping changes.
	0001 = A-1 Step	
V <sub>CC</sub>	0 = 5.0V Device	Indicates a device is 5.0 V.
Product Type	00 0100 (Indicates i960 CPU)	Designates type of product.
Generation Type	0011 = 80960RP-series	Indicates the generation or "family member" of the i960 CPU.
Model Type	0000 = 80960RP	Indicates member within a series and specific model information.
Manufacturer ID	000 0000 1001 (Indicates Intel)	Manufacturer ID assigned by IEEE.

Table 32. Device ID (DEVICEID), ATU ID (ATUID), and Revision ID (RIDR) Register Settings

Device and		DEVICEID	ATURID, RIDR
Stepping (1)	Complete ID (Hex)	Complete ID (Binary)	Complete ID (Binary)
80960RP A-0	00860013	0000 0000 1000 0110 0000 0000 0001 0011	0000 0000
80960RP A-1	10860013	0001 0000 1000 0110 0000 0000 0001 0011	0000 0001

#### NOTES:

1. The device and stepping designator is printed on the top side of the package.



# 7.0 REVISION HISTORY

Table 33. Revision History (Rev. -001 to -002)

Section	Description
3.1.1, Functional Signal Definitions (pg. 8)	In all signal description tables, signals are now listed alphabetically and general clarification changes have been made.
Table 5., Power Requirement, Processor Control and Test Signal Descriptions (pg. 13)	Added new entries for L_RST# and V <sub>CCPLL3:1</sub> .
Table 10., Clock Signal (pg. 20)	Created new table and redefined S_CLK clock signal.
Table 11., ICE Signal Descriptions (pg. 20)	Added table to define ICE signals.
3.1.2, 352-Lead HL-PBGA Package (pg. 21)	Modified section to include new package illustrations; added signal-to-ball cross reference tables.
3.2, Package Thermal Specifications (pg. 31)	Added thermal specifications section.
4.0, ELECTRICAL SPECIFICATIONS (pg. 34)	Added DC, AC specifications and related timing diagrams. These specifications are derived from simulations.
5.0, BUS FUNCTIONAL WAVEFORMS (pg. 55)	Removed several PCI-related waveforms.
Figure 33., 80960 Local Bus Warm Reset Waveform (pg. 63)	Added waveform.
6.0, DEVICE IDENTIFICATION ON RESET (pg. 64)	Added section.

Table 34. Revision History (Rev. -002 to -003) (Sheet 1 of 2)

Section	Description
(throughout document)	Removed all references to P_CLK and SYNC.
Table 4, Signal Descriptions (pg. 9)	Revised signal Descriptions for BE3:0#, DEN#, D/C#/RST_MODE#,LOCK#/ONCE#, LRDYRCV#, WIDTH/HLTD0 and WIDTH/HLTD1/RETRY
Table 5, Power Requirement, Processor Control and Test Signal Descriptions (pg. 13)	Revised signal Descriptions for TDI, TDO and TMS
Table 7, PCI Signal Descriptions (pg. 15)	Added new Type entries for P_LOCK#.
	Removed Type entries K(Q) or K(Z) from several signals.
	Changed P_CLK to S_CLK in P_INT[A:D]# and P_RST#.
	Revised Description for S_RST#.
	Changed S_RST# to P_RST# in S_REQ5#/ S_ARB_EN.
Table 8, Memory Controller Signal Descriptions (pg. 18)	Revised Descriptions for CAS7:0# and RAS3:0#.



Table 34. Revision History (Rev. -002 to -003) (Sheet 2 of 2)

Section	Description
3.1.2, 352-Lead HL-PBGA Package (pg. 21)	Updated section to show new package type, including new figures and tables.
	Specific signal name changes are: PCLK is renamed to VCC or VSS; WIDTH/HLTD0/SYNC is renamed to WIDTH/HLTD0
Section 3.2, Package Thermal Specifications (pg. 31)	Revised text and added figures and table.
Section 4.1, Absolute Maximum Ratings (pg. 34)	Revised Case Temperature from 85° C to 115° C.
Table 16, Operating Conditions (pg. 34)	Revised T <sub>C</sub> Max.
Table 17, DC Characteristics (pg. 35)	Set values for V <sub>OL4</sub> , I <sub>OL4</sub> and V <sub>OH4</sub> , I <sub>OH4</sub> TBDs.
Table 18, I <sub>CC</sub> Characteristics (pg. 36)	Set values for parameters which were previously TBDs.
Table 19, Input Clock Timings (pg. 37)	Removed T <sub>F</sub> note.
Table 20, Synchronous Output Timings (pg. 37)	Revised T <sub>OV3</sub> Max.
Table 21, Synchronous Input Timings (pg. 38)	Revised Min for $T_{\rm IS1}$ and $T_{\rm IS6}$ . Added Note 5 to $T_{\rm IS1}$ , $T_{\rm IS6}$ and $T_{\rm IH6}$ . Revised parameters for $T_{\rm IS3}$ and $T_{\rm IH3}$ .
	Added T <sub>IS9</sub> and T <sub>IH9</sub> .
Table 23, Fast Page Mode Non-interleaved DRAM Output Timings (pg. 39)	Revised all Min values.
	Revised all Max values except T <sub>OV9</sub> and T <sub>OV11</sub> .
Table 24, Fast Page Mode Interleaved DRAM Output Timings (pg. 39)	Revised all Min values. Revised all Max values for $T_{OV12}$ , $T_{OV13}$ , $T_{OV14}$ and $T_{OV16}$ .
Table 25, EDO DRAM Output Timings (pg. 40)	Revised all Min values.
	Revised all Max values except $T_{OV}$ 27 and $T_{OV}$ 30.
Table 26, BEDO DRAM Output Timings (pg. 41)	Revised all Min values.
Table 27, SRAM/ROM Output Timings (pg. 41)	Revised all Min values.
Table 28, Boundary Scan Test Signal Timings (pg. 42)	Revised Min values for T <sub>BSF</sub> , T <sub>BSIS1</sub> , T <sub>BSIH1</sub> , T <sub>BSIS2</sub> and T <sub>BSIH2</sub> .
	Revised Max values for T <sub>BSOF1</sub> and T <sub>BSOF2</sub> .
Section 4.6, Memory Controller Output Timing Waveforms (pg. 48)	Revised Figure 15, (pg. 48) to Figure 24, (pg. 54).
Section 5.0, BUS FUNCTIONAL WAVEFORMS (pg. 55)	Revised Figure 31, (pg. 61) to Figure 33, (pg. 63)
Section 6.0, DEVICE IDENTIFICATION ON RESET (pg. 64)	Added Figure 34, (pg. 64) Revised Table 31, 80960RP Device ID Register Field Definitions (pg. 64).